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DS90UB935-Q1

SNLS605-JULY 2018

# DS90UB935-Q1 FPD-Link III 3-Gbps Serializer With CSI-2 Interface

### Features

- AEC-Q100 Qualified for Automotive Applications:
  - Device Temperature Grade 2: –40°C to +105°C Ambient Operating Temperature
- ISO 10605 and IEC 61000-4-2 ESD Compliant
- Power-over-Coax (PoC) Compatible Transceiver
- 3-Gbps Grade Serializer Supports High-Speed Sensors
- D-PHY v1.2 and CSI-2 v1.3 Compliant System Interface
  - Up to 2.528-Gbps CSI-2 Bandwidth
  - Supports up to Four Virtual Channels
- Precision Multi-Camera Clocking and Synchronization
- Flexible Programmable Output Clock Generator
- Advanced Data Protection and Diagnostics . Including CRC Data Protection, Sensor Data Integrity Check, I2C Write Protection, Voltage and Temperature Measurement, Programmable Alarm, and Line Fault Detection
- Supports Single-Ended Coaxial or Shielded-Twisted-Pair (STP) Cable
- Ultra-Low Latency Bidirectional I2C and GPIO Control Channel Enables ISP Control From ECU
- Single 1.8-V Power Supply
- Low (0.25 W Typical) Power Consumption
- Compatible With DS90UB936-Q1, DS90UB954-Q1, DS90UB960-Q1, DS90UB934-Q1, DS90UB914A-Q1 Deserializers
- Wide Temperature Range: -40°C to 105°C
- Small 5-mm × 5-mm VQFN Package and PoC Solution Size for Compact Camera Module Designs

#### **Applications** 2

- Automotive Driver Assistance Systems (ADAS)
- Surround View Systems (SVS)
- Camera Monitor Systems (CMS)
- Forward Vision Cameras (FC)
- Driver Monitoring Systems (DMS)
- Rear-View Cameras (RVC)
- Automotive Satellite RADAR & LIDAR Modules Time-of-Flight (ToF) Sensors
- Security and Surveillance Cameras
- Industrial and Medical Imaging

#### Description 3

The DS90UB935-Q1 serializer is part of TI's FPD-Link III device family designed to support high-speed data sensors including cameras, satellite raw RADAR, LIDAR, and Time-of-Flight (ToF) sensors. The chip delivers a high-speed forward channel and an ultra-low latency, bidirectional control channel and supports power over a single coax (PoC) or STP cable. The DS90UB935-Q1 features advanced data protection and diagnostic features to support ADAS and autonomous driving. Together with a companion deserializer, the DS90UB935-Q1 delivers precise multi-camera sensor clock and sensor synchronization.

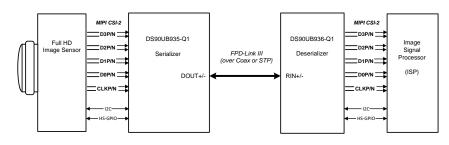
The DS90UB935-Q1 is fully AEC-Q100 gualified with a -40°C to 105°C wide temperature range. AECQ100 qualification includes HBM ESD Classification Level 3A and CDM ESD Classification Level C6. The serializer comes in a small 5-mm × 5-mm VQFN package for space-constrained sensor applications.

D	)evice	Informa	ation <sup>(1)</sup>	

PART NUMBER	PACKAGE	BODY SIZE (NOM)
DS90UB935-Q1	VQFN (32)	5.00 mm × 5.00 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### **Typical Application**





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# **Table of Contents**

1	Feat	tures 1
2	Арр	lications1
3	Des	cription1
4	Rev	ision History 2
5	Pin	Configuration and Functions 3
6	Spe	cifications5
	6.1	Absolute Maximum Ratings 5
	6.2	ESD Ratings
	6.3	Recommended Operating Conditions 5
	6.4	Thermal Information 6
	6.5	Electrical Characteristics7
	6.6	Recommended Timing for the Serial Control Bus 11
	6.7	Timing Diagrams 12
	6.8	Typical Characteristics 12
7	Deta	ailed Description 13
	7.1	Overview 13
	7.2	Functional Block Diagram 13
	7.3	Feature Description 14
	7.4	Device Functional Modes 20
	7.5	Programming 24

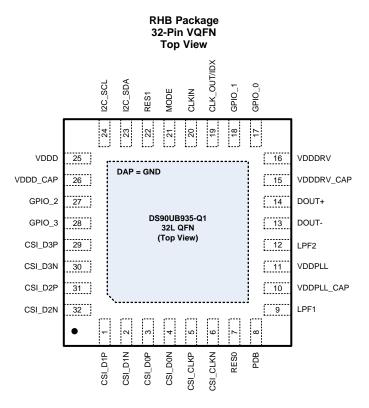
	7.6	Pattern Generation	26
	7.7	Register Maps	30
8	Арр	lication and Implementation	67
	8.1	Application Information	67
	8.2	Typical Applications	70
9	Pow	er Supply Recommendations	73
	9.1	Power-Up Sequencing	73
	9.2	Power Down (PDB)	74
10	Lay	out	74
	10.1	Layout Guidelines	74
	10.2	Layout Examples	75
11	Dev	ice and Documentation Support	78
	11.1	Device Support	78
	11.2	Documentation Support	78
	11.3	Receiving Notification of Documentation Updates	78
	11.4	Community Resources	78
	11.5	Trademarks	78
	11.6	Electrostatic Discharge Caution	78
	11.7	Glossary	78
12		hanical, Packaging, and Orderable mation	79

# 4 Revision History

DATE	REVISION	NOTES
July 2018	*	Initial release.



### 5 Pin Configuration and Functions



#### **Pin Functions**

PIN		- I/O	DESCRIPTION		
NAME	NO.				
CSI INTERFACE	1				
CSI_CLKP	5	I, DPHY	CSI-2 clock input pins. Connect to a CSI-2 clock source with matched 100- $\Omega$ (±5%) impedance		
CSI_CLKN	6	I, DPHY	interconnects.		
CSI_D0P	3	I, DPHY			
CSI_D0N	4	I, DPHY			
CSI_D1P	1	I, DPHY			
CSI_D1N	2	I, DPHY	CSI-2 data input pins. Connect to a CSI-2 data sources with matched 100- $\Omega$ (±5%) impedance		
CSI_D2P	31	I, DPHY	interconnects. If unused, these pins may be left floating.		
CSI_D2N	32	I, DPHY			
CSI_D3P	29	I, DPHY			
CSI_D3N	30	I, DPHY			
SERIAL CONTRO	L INTERFACE				
I2C_SDA	23	OD	I2C Data and Clock Pins. Typically pulled up by 470-Ω to 4.7-kΩ resistors to either 1.8-V or 3.3-V supply		
I2C_SCL	24	OD	rail depending on IDX setting. See <i>I2C Interface Configuration</i> for further details on the I2C implementation of the DS90UB935-Q1.		
CONFIGURATION	and CONTROL				
RES0	7	I	Reserved pin – Connect to GND		
RES1	22	I	Reserved pin – Do not connect (leave floating)		
PDB	8	I, PD	Power-down inverted Input Pin. Internal 1-MΩ pulldown. Typically connected to processor GPIO with pull down. When PDB input is brought HIGH, the device is enabled and internal register and state machines are reset to default values. Asserting PDB signal low will power down the device and consume minimum power. The default function of this pin is PDB = LOW; POWER DOWN. PDB should remain low until after power supplies are applied and reach minimum required levels. See <i>Power Down (PDB)</i> for further details on the function of PDB. <b>PDB INPUT IS NOT 3.3-V TOLERANT</b> . PDB = 1.8 V, device is enabled (normal operation) PDB = 0, device is powered down.		



### Pin Functions (continued)

PIN	1			
NAME	NO.		DESCRIPTION	
MODE	21	I, S	Mode select configuration input. Default operational mode will be strapped at start-up based on the MODE input voltage when PDB transitions LOW to HIGH. Typically connected to voltage divider through external pullup to VDD18 and pulldown to GND applying an appropriate bias voltage. See <i>MODE</i> for detail.	
CLK_OUT/IDX	19	I/O, S	IDX pin sets the I2C pullup voltage and device address; connect to external pullup to VDD and pulldow to GND to create a voltage divider. When PDB transitions LOW to HIGH, the strap input voltage is sen at the CLOCK_OUT/IDX pin to determine functionality and then converted to CLK_OUT. See <i>I2C Interc Configuration</i> for detail. If CLK_OUT is used, the minimum resistance on the pin is 35 kΩ. If unused, CLK_OUT/IDX may be tied to GND.	
FPD-LINK III INTER	RFACE			
DOUT-	13	I/O	FPD-Link III Input/Output pins. These pins must be AC-coupled. See Figure 19 and Figure 20 for typical	
DOUT+	14	I/O	connection diagrams and Table 178 for recommended capacitor values.	
POWER AND GRO	UND			
VDDD_CAP	26	D, P	A connection for internal analog regulator decoupling capacitor. Typically connected to $10-\mu$ F, $0.1-\mu$ F, and $0.01-\mu$ F capacitors to GND. Do not connect to an external supply rail. See <i>Typical Application</i> for more details.	
VDDDRV_CAP	15	D, P	A connection for internal analog regulator decoupling capacitor. Typically connected to $10-\mu$ F, $0.1-\mu$ F, and $0.01-\mu$ F capacitors to GND. Do not connect to an external supply rail. See <i>Typical Application</i> for more details.	
VDDPLL_CAP	10	D, P	A connection for internal analog regulator decoupling capacitor. Typically connected to $10-\mu$ F, $0.1-\mu$ F, and $0.01-\mu$ F capacitors to GND. Do not connect to an external supply rail. See <i>Typical Application</i> for more details.	
VDDD	25	Р	1.8-V ( $\pm$ 5%) Power Supply pin. Typically connected to 1-µF and 0.01-µF capacitors to GND.	
VDDDRV	16	Р	1.8-V (±5%) Analog Power Supply pin. Typically connected to 1- $\mu F$ and 0.01- $\mu F$ capacitors to GND.	
VDDPLL	11	Р	1.8-V (±5%) Analog Power Supply pin. Typically connected to 1- $\mu F$ and 0.01- $\mu F$ capacitors to GND.	
GND	DAP	G	DAP is the large metal contact at the bottom side, located at the center of the VQFN package. Connect to the ground plane (GND).	
LOOP FILTER				
LPF1	9	Р	Loop Filter 1: Connect as described in Loop Filter Decoupling.	
LPF2	12	Р	Loop Filter 2: Connect as described in Loop Filter Decoupling.	
CLOCK INTERFAC	E and GPIO			
GPIO_0	17	I/O, PD	General-Purpose Input/Output pins. These pins can also be configured to sense the voltage at their	
GPIO_1	18	I/O, PD	inputs. See Voltage and Temperature Sensing. At power-up these GPIO pins default to inputs with a 300 kΩ (typical) internal pulldown resistor. If unused, these pins may be left floating, however, it is recommended to disable them by setting the GPIOx_INPUT_EN to 0. See GPIO Support for programmability.	
GPIO_2	27	I/O, PD	General-Purpose Input/Output pins. At power-up these GPIO pins default to inputs with a 300 k $\Omega$ (typical)	
GPIO_3	28	I/O. PD	internal pulldown resistor. If unused, these pins may be left floating, however, it is recommended to disable them by setting the GPIOx_INPUT_EN to 0. See <i>GPIO Support</i> for programmability.	
CLKIN	20	I	Reference Clock Input pin. If operating in Non Sync external clock mode, connect this pin to a local clock source. If unused (other clocking modes), this pin may be left open. See Table 6 for more information on clocking modes.	



### 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

	PIN OR FREQUENCY	MIN	MAX	UNIT
Supply voltage, VDD	VDDD, VDDDRV, VDDPLL	-0.3	2.16	V
Input voltage	GPIO[3:0], PDB, CLKIN, IDX, MODE, CSI_CLKP/N, CSI_D0P/N, CSI_D0P/N, CSI_D1P/N, CSI_D2P/N, CSI_D3P/N	-0.3	V <sub>DD</sub> + 0.3	V
FPD-Link III output voltage	DOUT+, DOUT-	-0.3	1.21	V
Open-drain voltage	I2C_SDA, I2C_SCL	-0.3	3.96	V
Junction temperature, T <sub>J</sub>			150	°C
Storage termperature, T <sub>stg</sub>		-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

				VALUE	UNIT
		Human body model (HBM) ESD	All pins except Media Dependent Interface Pins	. 1000	V
		Classification Level 3A, per AEC Q100-002 <sup>(1)</sup>	Media Dependent Interface Pins	±4000	V
			assification Level C6, per AEC Q100-	±1500	V
V <sub>(ESD)</sub>	Electrostatic discharge		5	±8000	V
			0	±18000	V
			5	±8000	V
			±18000	V	

(1) AEC Q100-002 indicates HBM stressing is done in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

### 6.3 Recommended Operating Conditions

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage	VDD (VDDD, VDDDRV, VDDPLL)	1.71	1.8	1.89	V
Open-drain voltage	I2C_SDA, I2C_SCL = $V_{(I2C)}$	1.71		3.6	V
Operating free-air temperature (T <sub>A</sub> )		-40	25	105	°C
Mipi data rate (per CSI-2 lane)		80		832	Mbps
Mipi combined data rate				2.5	Gbps
Reference clock input frequency		25		104	MHz
Local I <sup>2</sup> C frequency (f <sub>I2C</sub> )				1	MHz

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### **Recommended Operating Conditions (continued)**

Over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply noise	VDD (VDDD, VDDDRV, VDDPLL)			25	mV <sub>p-p</sub>
Differential supply poise between DOUT, and DOUT	f = 10 KHz - 50 MHz (coax mode only)			25	mV <sub>p-p</sub>
Differential supply noise between DOUT+ and DOUT- (PSR)	f = 30 Hz, 10-90% Rise/Fall Time > 100μs (coax mode only)			25	mV <sub>p-p</sub>
Input clock jitter for non synchronous mode $(t_{JIT})$	CLKIN			0.05	UI_CLK_I N <sup>(1)</sup>
Back channel input jitter (t <sub>JIT-BC</sub> )	DOUT+, DOUT-			0.4	UI_BC <sup>(2)</sup>

(1) Non-synchronous mode - For a given clock, the UI is defined as 1/clock\_freq. For example when the clock = 50Mhz, the typical UI\_CLK\_IN is 1/50 MHz = 20 ns.

(2) The back channel unit interval (UI\_BC) is 1/(BC line-rate). For example, the typical UI\_BC is 1/100 MHz = 10 ns. If the jitter tolerance is 0.4 UI, convert the jitter in UI to seconds using this equation: 10 ns x 0.4 UI = 4 ns

#### 6.4 Thermal Information

		DS90UB935Q-Q1	
	THERMAL METRIC <sup>(1)</sup>	RHB (VQFN)	UNIT
		32 PINS	
$R_{\thetaJA}$	Junction-to-ambient thermal resistance	31.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	10.9	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	20	°C/W
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	1	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	0.2	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	10.9	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.

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EXAS

6



### 6.5 Electrical Characteristics

	PARAMETER	TEST CONDITIONS	PIN OR FREQUENCY	MIN	TYP	МАХ	UNIT
POWER C	ONSUMPTION						
I <sub>DD_TOTAL</sub>			VDDPLL, VDDD, VDDDRV		160	225	
I <sub>DDPLL</sub>	Supply current	4 Lane Mode, Checkerboard Pattern	VDDPLL		55	80	mA
I <sub>DDD</sub>			VDDD		45	70	
IDDDRV			VDDDRV		60	75	L
1.8-V LVC	MOS I/O (VDD) = 1.71 V to	1.89 V)					
V <sub>OH</sub>	High level output voltage	I <sub>OH</sub> = -4 mA	GPIO[3:0], CLK_OUT	V <sub>(VDD)</sub> – 0.45		V <sub>(VDD)</sub>	V
V <sub>OL</sub>	Low level output voltage	I <sub>OL</sub> = +4 mA	GPIO[3:0], CLK_OUT	GND		0.45	V
V <sub>IH</sub>	High level input voltage		GPIO[3:0], PDB, CLKIN	V <sub>(VDD)</sub> × 0.65		V <sub>(VDD)</sub>	V
V <sub>IL</sub>	Low level input voltage		GPIO[3:0], PDB, CLKIN	GND		V <sub>(VDD)</sub> × 0.35	V
I <sub>IH</sub>	Input high current	V <sub>IN</sub> = V <sub>(VDD)</sub>	GPIO[3:0], PDB, CLKIN			20	μA
I <sub>IL</sub>	Input low current	V <sub>IN</sub> = GND	GPIO[3:0], PDB, CLKIN	-20			μA
I <sub>OS</sub>	Output short-circuit current	V <sub>OUT</sub> = 0 V			-36		mA
I <sub>OZ</sub>	TRI-STATE output current	V <sub>OUT</sub> = V <sub>(VDD)</sub> , V <sub>OUT</sub> = GND	GPIO[3:0], CLK_OUT			±20	μA
C <sub>IN</sub>	Input capacitance				5		рF

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### **Electrical Characteristics (continued)**

	PARAMETER	TEST CONDITIONS	PIN OR FREQUENCY	MIN	ТҮР	МАХ	UNIT
FPD-LINI	K III INPUT/OUTPUT	1	L I				
V <sub>IN-BC</sub>	Single-ended input voltage	Coaxial configuration, 50 $\Omega,$ maximum cable length	DOUT+, DOUT-	120			mV
V <sub>ID-BC</sub>	Differential input voltage	STP configuration, 100 $\Omega$ , maximum cable length	DOUT+, DOUT-	240			mv
F	Forward channel eye	Coaxial configuration, FPD-Link forward channel = 4.16 Gbps	DOUT+, DOUT-		425		~\/n n
E <sub>H-FC</sub>	height	STP configuration, FPD-Link forward channel = 4.16 Gbps	DOUT+, DOUT-		850		mVp-p
t <sub>TR-FC</sub>	Forward channel output transition time	FPD-Link forward channel = 4.16Gbps; 20% to 80%	DOUT+, DOUT-		65		ps
	Forward channel output	Synchronous mode, measured with f/15 –3dB CDR Loop BW	DOUT+, DOUT-		0.21		UI
t <sub>JIT-FC</sub>	jitter	Non-synchronous mode, measured with f/15 –3dB CDR Loop BW	DOUT+, DOUT-		0.22		UI
f <sub>REF</sub>	Internal reference frequency	Non-synchronous internal clocking mode		24.2		25.5	MHz
FPD-LINI	K III DRIVER SPECIFICATIO	ONS (DIFFERENTIAL)					
V <sub>ODp-p</sub>	Output differential voltage	R <sub>L</sub> = 100 Ω	DOUT+, DOUT-	1040	1150	1340	mV <sub>p-p</sub>
$\Delta V_{OD}$	Output voltage imbalance		DOUT+, DOUT-		5	24	mV
V <sub>OS</sub>	Output differential offset voltage		DOUT+, DOUT-		575		mV
$\Delta V_{OS}$	Offset voltage imbalance		DOUT+, DOUT-		2		mV
I <sub>OS</sub>	Output short-circuit current	DOUT = 0 V	DOUT+, DOUT-		-22		mA
R <sub>T</sub>	Internal termination resistance	Between DOUT+ and DOUT-	DOUT+, DOUT-	80	100	120	Ω
FPD-LIN	K III DRIVER SPECIFICATIO	ONS (SINGLE-ENDED)					
V <sub>OUT</sub>	Output single-ended voltage	R <sub>L</sub> = 50 Ω	DOUT+, DOUT-	520	575	670	mV <sub>p-p</sub>
I <sub>OS</sub>	Output short-circuit current	DOUT = 0 V	DOUT+, DOUT-		-22		mA
R <sub>T</sub>	Single-ended termination resistance		DOUT+, DOUT-	40	50	60	Ω
VOLTAG	E AND TEMPERATURE SE	NSING					
V <sub>ACC</sub>	Voltage accuracy	See Voltage and Temperature Sensing	GPIO[1:0]		±1		LSB
T <sub>ACC</sub>	Temperature accuracy	See Voltage and Temperature Sensing			±1		LSB



### **Electrical Characteristics (continued)**

	PARAMETER	TEST CONDITIONS	PIN OR FREQUENCY	MIN	ТҮР	МАХ	UNIT
CSI-2 HS I	NTERFACE DC SPECIFICATION	NS					
V <sub>CMRX(DC)</sub>	Common-mode voltage HS receive mode		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N	70		330	mV
V <sub>IDTH</sub>	Differential input high threshold		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N			70	mV
V <sub>IDTL</sub>	Differential input low threshold		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N	-70			mV
Z <sub>ID</sub>	Differential input impedance		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N	80	100	125	Ω
CSI-2 HS I	NTERFACE AC SPECIFICATION	NS					
t <sub>HOLD</sub>	Data to clock setup time		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N	0.15			UI
t <sub>SETUP</sub>	Data to clock hold time		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N	0.15			UI
CSI-2 LP I	NTERFACE DC SPECIFICATION	IS					
V <sub>IH</sub>	Logic high input voltage		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N	880	790		mV
V <sub>IL</sub>	Logic low input voltage		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N		710	550	mV
V <sub>HYST</sub>	Input hysteresis		CSI_D3P/N, CSI_D2P/N, CSI_D1P/N, CSI_D0P/N, CSI_CLKP/N	25	75		mV

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### **Electrical Characteristics (continued)**

	PARAMETER	TEST CONDITIONS	PIN OR FREQUENCY	MIN	TYP	MAX	UNIT
LVCMO	S I/O		- · · · ·				
t <sub>CLH</sub>	LVCMOS low-to-high transition time	V <sub>(VDD)</sub> = 1.71 to 1.89 V	GPIO[3:0]		2		ns
t <sub>CHL</sub>	LVCMOS high-to-low transition time	V <sub>(VDD)</sub> = 1.71 to 1.89 V	GPIO[3:0]		2		ns
t <sub>PDB</sub>	PDB reset pulse width	Voltage supplies applied and stable	PDB	3			ms
SERIAL	CONTROL BUS						
V <sub>IH</sub>	Input high level		I2C_SCL, I2C_SDA	0.7 × V <sub>(I2C)</sub>		V <sub>(I2C)</sub>	mV
V <sub>IL</sub>	Input low level		I2C_SCL, I2C_SDA	GND		0.3 × V <sub>(I2C)</sub>	mV
$V_{\rm HY}$	Input hysteresis		I2C_SCL, I2C_SDA		>50		mV
		V <sub>(I2C)</sub> < 2 V, I <sub>OL</sub> = 3 mA, Standard- mode/Fast-mode	I2C_SCL, I2C_SDA	0		0.2 × V <sub>(I2C)</sub>	V
M		$V_{(I2C)}$ < 2 V, I <sub>OL</sub> = 20 mA, Fast-mode plus	I2C_SCL, I2C_SDA	0		0.2 × V <sub>(I2C)</sub>	V
V <sub>OL</sub>	Output low level	$V_{(I2C)} > 2 V$ , $I_{OL} = 3 mA$ , Standard- mode/Fast-mode	I2C_SCL, I2C_SDA	0		0.4	V
		$V_{(I2C)}$ > 2 V, I <sub>OL</sub> = 20 mA, Fast-mode plus	I2C_SCL, I2C_SDA	0		0.4	V
I <sub>IH</sub>	Input high current	V <sub>IN</sub> = V <sub>(I2C)</sub>	I2C_SCL, I2C_SDA	-10		10	μA
I <sub>IL</sub>	Input low current	V <sub>IN</sub> = 0 V	I2C_SCL, I2C_SDA	-10		10	μA
I <sub>IL</sub>	Input low current	V <sub>IN</sub> = 0 V	I2C_SCL, I2C_SDA	-10		10	μA
C <sub>IN</sub>	Input capacitance		I2C_SCL, I2C_SDA		5		pf



### 6.6 Recommended Timing for the Serial Control Bus

Over I<sup>2</sup>C supply and temperature ranges unless otherwise specified.

			MIN	TYP MAX	UNIT
		Standard-mode	>0	100	kHz
f <sub>SCL</sub>	SCL Clock Frequency	Fast-mode	>0	400	kHz
		Fast-mode Plus	>0	1	MHz
		Standard-mode	4.7		μs
t <sub>LOW</sub>	SCL Low Period	Fast-mode	1.3		μs
		Fast-mode Plus	0.5		μs
		Standard-mode	4.0		μs
t <sub>HIGH</sub>	SCL High Period	Fast-mode	0.6		μs
		Fast-mode Plus	0.26		μs
		Standard-mode	4.0		μs
t <sub>HD;STA</sub>	SCL Low Period         TA       SCL High Period         TA       Hold time for a start or a repeated start condition         TA       Set up time for a start or a repeated start condition         AT       Data hold time         AT       Data set up time         TO       Set up time for STOP condition         Bus free time between STOP and START         SCL & SDA rise time         Capacitive load for each bus line         AT         Data valid time	Fast-mode	0.6		μs
, -		Fast-mode Plus	0.26		μs
		Standard-mode	4.7		μs
t <sub>SU;STA</sub>	Set up time for a start or a repeated start condition	Fast-mode	0.6		μs
		Fast-mode Plus	0.26		μs
		Standard-mode	0		μs
t <sub>HD;DAT</sub>	Data hold time	Fast-mode	0		μs
		Fast-mode Plus	0		μs
t <sub>SU;DAT</sub>	Data set up time	Standard-mode	250		ns
		Fast -mode	100		ns
		Fast-mode Plus	50		ns
		Standard-mode	4.0		μs
t <sub>SU;STO</sub>	Set up time for STOP condition	Fast-mode	0.6		μs
-50,510		Fast-mode Plus	0.26		μs
		Standard-mode	4.7		μs
t <sub>BUF</sub>	H       SCL High Period         STA       Hold time for a start or a repeated start condition         STA       Set up time for a start or a repeated start condition         DAT       Data hold time         DAT       Data set up time         STO       Set up time for STOP condition         Bus free time between STOP and START         SCL & SDA rise time         SCL & SDA fall time         Data valid time	Fast-mode	1.3		μs
BUF		Fast-mode Plus	0.5		μs
		Standard-mode	0.0	1000	ns
t <sub>r</sub>	SCL & SDA rise time	Fast-mode		300	ns
4		Fast-mode Plus		120	ns
		Standard-mode		300	ns
t <sub>f</sub>	SCL & SDA fall time	Fast-mode		300	ns
ч		Fast-mode Plus		120	ns
		Standard-mode		400	pF
C <sub>b</sub>	Capacitive load for each bus line	Fast-mode		400	pF
Ъ		Fast-mode Plus		550	pF
tup p :=	Data valid time	Standard-mode		3.45	
t <sub>VD:DAT</sub>		Fast-mode		0.9	μs
		Fast-mode Plus		0.9	μs
t	Data vallid acknowledge time	Standard-mode		3.45	μs
t <sub>VD;ACK</sub>	Data valliu acknowleuge time			0.9	μs
		Fast-mode			μs
		Fast-mode Plus		0.45	μs
t <sub>SP</sub>	Input filter	Fast-mode		50	ns ns
t <sub>SP</sub>	Input filter	Fast-mode Plus		50	



#### 6.7 Timing Diagrams

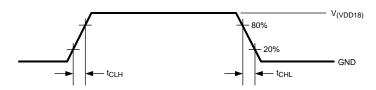


Figure 1. LVCMOS Transition Times

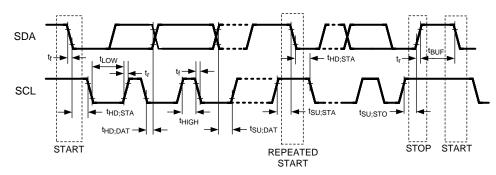


Figure 2. I<sup>2</sup>C Serial Control Bus Timing

# 6.8 Typical Characteristics

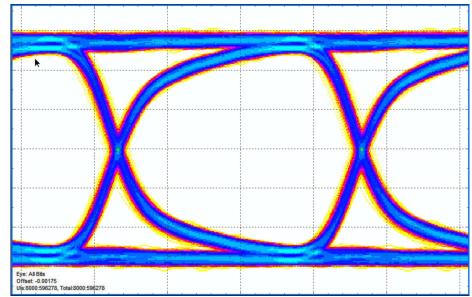


Figure 3. Eye Diagram at 3-Gbps FPD-Link III Forward Channel Rate From Serializer Output Vertical Scale: 100 mV/DIV Horizontal Scale: 100 ps/DIV



### 7 Detailed Description

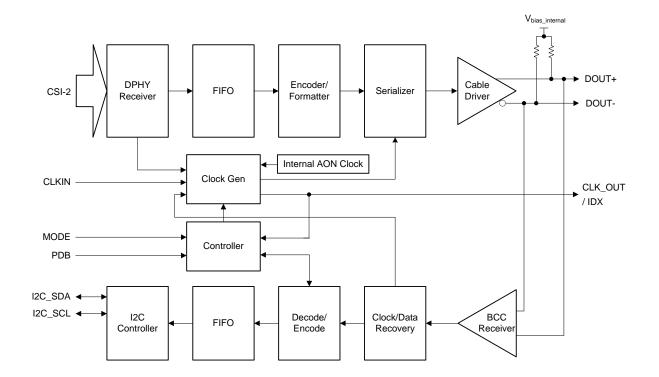
#### 7.1 Overview

The DS90UB935-Q1 serializes data from high-resolution image sensors or other sensors using the MIPI CSI-2 interface. The DS90UB935-Q1 serializer is optimized to interface with the DS90UB936-Q1 or DS90UB954-Q1 deserializer (dual hub), the DS90UB960-Q1 deserializer (quad hub), the DS90UB934-Q1 and DS90UB914A-Q1 deserializers, as well as potential future deserializers. The interconnect between the serializer and the deserializer can be either a coaxial cable or shielded-twisted pair (STP) cable. The DS90UB935-Q1 was designed to support multi-sensor systems such as surround view, and as such has the ability to synchronize sensors through the DS90UB935-Q1, DS90UB954-Q1, and DS90UB960-Q1 hubs.

The DS90UB935-Q1 serializer and companion deserializer incorporate an  $I^2$ C-compatible interface. The  $I^2$ C-compatible interface allows programming of serializer or deserializer devices from a local host controller. In addition, the devices incorporate a bidirectional control channel (BCC) that allows communication between the serializer and deserializer as well as remote  $I^2$ C slave devices.

The bidirectional control channel (BCC) is implemented through embedded signaling in the high-speed forward channel (serializer to deserializer) combined with lower speed signaling in the reverse channel (deserializer to serializer). Through this interface, the BCC provides a mechanism to bridge I<sup>2</sup>C transactions across the serial link from one I<sup>2</sup>C bus to another.

#### 7.2 Functional Block Diagram





#### 7.3 Feature Description

The DS90UB935-Q1 FPD-Link III serializer is designed to support high-speed raw data sensors including cameras, satellite RADAR, LIDAR, and Time-of-Flight (ToF) sensors. The chip features a forward channel capable of up to 3.16 Gbps and an ultra-low latency 50-Mbps bidirectional control channel. The transmission of the forward channel, bidirectional control channel, and power is supported over coaxial (Power-over-Coax) or STP cables. The DS90UB935-Q1 features advanced data protection and diagnostic features to support ADAS and autonomous driving. Together with a companion deserializer, the DS90UB935-Q1 delivers precise multi-camera sensor clock and sensor synchronization.

#### 7.3.1 CSI-2 Receiver

The DS90UB935-Q1 receives CSI-2 video data from the Sensor. During CSI-2 operation, the D-PHY consists of a clock lane and one or more data lanes. The DS90UB935-Q1 is a Slave Device and only supports Unidirectional Lane in the Forward direction. Low Power Escape mode is not supported.

#### 7.3.1.1 CSI-2 Receiver Operating Modes

During normal operation a Data Lane will be in either Control or High-Speed mode. In High-Speed mode, the data transmission happens in a burst and starts and ends at a Stop state (LP-11). There is a transition state to take the D-PHY from a Normal mode to the Low-Power state.

The sequence to enter High-Speed mode is: LP-11, LP-01, LP-00. After the sequence is entered, the Data Lane remains in High-Speed mode until a Stop state (LP-11) is received.

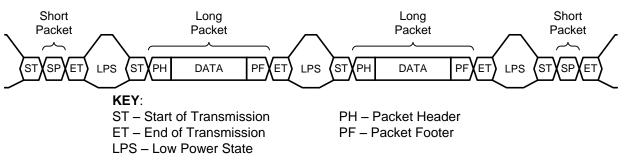
#### 7.3.1.2 CSI-2 Receiver High-Speed Mode

During high-speed data transmission, the digital D-PHY will enable termination signal to allow proper termination of the HS RX of the Analog D-PHY, and the LP RX should stay at LP-00 state. Both CSI-2 data lane and clock lane operate in the same manner. The DS90UB935-Q1 supports CSI-2 continuous clock lane mode where the clock lane remains in high-speed mode.

#### 7.3.1.3 CSI-2 Protocol Layer

There are two different types of CSI-2 packets: a short packet and a long packet. Short packets have information such as the Frame Start/ Line Start, and long packets carry the data after the frame start is asserted. Figure 4 shows the structure of the CSI-2 protocol layer with short and long packets. The DS90UB935-Q1 supports 1, 2, and 4 lane configurations.





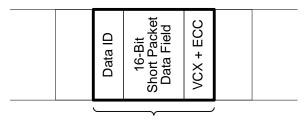
#### Figure 4. CSI-2 Protocol Layer With Short and Long Packets

#### 7.3.1.4 CSI-2 Short Packet

The short packet provides frame or line synchronization. Figure 5 shows the structure of a short packet. A short packet is identified by data types 0x00 to 0x0F.



#### Feature Description (continued)

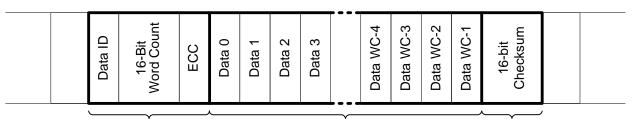


#### **32-bit SHORT PACKET (SH)** Data Type (DT) = 0x00 – 0x0F

#### Figure 5. CSI-2 Short Packet Structure

#### 7.3.1.5 CSI-2 Long Packet

A long packet consists of three elements: a 32-bit packet header (PH), an application-specific data payload with a variable number of 8-bit data words, and a 16-bit packet footer (PF). The packet header is further composed of three elements: an 8-bit data identifier, a 16-bit word count field, and an 8-bit ECC. The packet footer only has one element—a 16-bit checksum. Figure 6 shows the structure of a long packet.



32-bit PACKET HEADER (PH) **PACKET DATA:** Length = Word Count (WC) \* Data Word Width (8-bits). There are NO restrictions on the values of the data words

Figure 6. CSI-2 Long Packet Structure

PACKET PART	FIELD NAME	SIZE (BIT)	DESCRIPTION
	VC / Data ID	8	Contains the virtual channel identifier and the data-type information.
Header	Word Count	16	Number of data words in the packet data. A word is 8 bits.
ricador	ECC	8	ECC for data ID and WC field. Allows 1-bit error recovery and 2-bit error detection.
Data	Data	WC × 8	Application-specific payload (WC words of 8 bits).
Footer	Checksum	16	16-bit cyclic redundancy check (CRC) for packet data.

#### 7.3.1.6 CSI-2 Errors and Detection

#### 7.3.1.6.1 CSI-2 ECC Detection and Correction

CSI-2 packet header contains 6-bit Error Correction Code (ECC). ECC code in the 32-bit long packet header can be corrected when there is a 1-bit error and detected when there is a 2-bit error. This feature is added to monitor the CSI-2 input for ECC 1-bit error correction. When ECC error is detected, ECC error detection register will be set and an alarm indicator bit can be sent to the Deserializer to indicate the ECC error has been detected. A register control can be used to either enable or disable the alarm. See Table 39.

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16-bit

PACKET

FOOTER

(PF)



#### 7.3.1.6.2 CSI-2 Check Sum Detection

A CSI-2 long packet header contains a 16-bit check sum before the end of transmission. The DS90UB935-Q1 calculates the check sum of the incoming CSI-2 data. If a check sum error is detected, the check sum error status will be saved in the CSI\_ERR\_STATUS register (0x5D) and can also be forwarded to the deserializer through the bidirectional control channel.

#### 7.3.1.6.3 CSI-2 Receiver Status

For the Receive ports, several status functions can be tracked and monitored through register access. The status indications are available for error conditions as well as indications of change in line length measurements. These are available through the CSI\_ERR\_CNT (0x5C), CSI\_ERR\_STATUS (0x5D), CSI\_ERR\_DLANE01 (0x5E), CSI\_ERR\_DLANE23 (0x5F), and CSI\_ERR\_CLK\_LANE (0x60) registers.

#### 7.3.2 FPD-Link III Forward Channel Transmitter

The DS90UB935-Q1 features a high-speed signal transmitter capable of driving signals at rates of up to 3.16 Gbps.

#### 7.3.2.1 Frame Format

The DS90UB935-Q1 formats the data into 40-bit long frames. Each frame is encoded to ensure DC balance and to ensure sufficient data line transitions. Each frame contains video payload data, I<sup>2</sup>C forward channel data, CRC information, framing information, and information regarding the state of the CSI-2 interface.

#### 7.3.3 FPD-Link III Back Channel Receiver

The FPD-Link III back channel receives an encoded back channel signal over the FPD-Link III interface. The back channel frame is a 30-bit frame that contains I<sup>2</sup>C commands and GPIO data. The back channel frame receives an encoded clock and data from the deserializer, thus the data bit rate is one-half the frequency of the highest frequency received.

The back channel frequency is programmable for operation with compatible deserializers. The default setting is determined by the MODE strap pin. For operation with the DS90UB936-Q1, DS90UB954-Q1, or DS90UB960-Q1, the back channel should be programmed for 50-Mbps operation in DS90UB935-Q1 Synchronous mode and programmed for 10-Mbps operation for non-synchronous modes.

#### 7.3.4 Serializer Status and Monitoring

The DS90UB935-Q1 features enhanced FPD-Link III diagnostics, system monitoring, and Built-In Self Test capabilities. It monitors forward channel and back channel data for errors and reports them in the status registers. It also supports voltage and temperature measurement for system level diagnostics. The Built-In Self Test feature allows testing of the forward channel and back channel data transmissions without external data connections.

#### 7.3.4.1 Forward Channel Diagnostics

The DS90UB935-Q1 monitors the status of the forward channel link. The forward channel high-speed PLL lock status is reported in the HS\_PLL\_LOCK bit (Register 0x52[2]). When paired with the DS90UB936-Q1 or DS90UB954-Q1, the FPD-Link III deserializer LOCK status is also reported in the RX\_LOCK\_DETECT bit (Register 0x52[6]).

#### 7.3.4.2 Back Channel Diagnostics

The DS90UB935-Q1 monitors the status of the back channel link. The back channel CRC errors are reported in the CRC\_ERR bit (Register 0x52[1]). The number of CRC errors are stored in the CRC error counters and reported in the CRC\_ERR\_CNT1 (Register 0x55) and CRC\_ERR\_CNT2 (Register 0x56) registers. The CRC error counters are reset by setting the CRC\_ERR\_CLR (Register 0x49[3]) to 1.

When running the BIST function, the DS90UB935-Q1 reports if a BIST CRC error is detected in the BIST\_CRC\_ERR bit (Register 0x52[3]). The number of BIST errors are reported in the BIST\_ERR\_CNT field (Register 0x54). The BIST CRC error counter is reset by setting the BIST\_CRC\_ERR\_CLR (Register 0x49[5]) to 1.



#### 7.3.4.3 Voltage and Temperature Sensing

The DS90UB935-Q1 supports voltage measurement and temperature measurement. The temperature and voltage sensors are both equipped with a 3-bit ADC. These sensors can be configured to monitor a signal and raise a flag when a signal goes outside of a set limit. For example, a voltage sensor can be used to monitor the 1.8-V line and raise a flag if the voltage goes above 1.85 V or below 1.75 V. This flag can then be transferred to the deserializer and can set an interrupt at the deserializer end of the link. In a similar manner, the temperature sensor will trigger an alarm bit when the internal temperature of DS90UB935-Q1 is outside the range.

Both GPIO0 and GPIO1 can be configured to sense the voltage applied at their inputs. Table 32 through Table 38 cover the registers specific to this section.

For a given voltage or temperature, the measurement accuracy is  $\pm 1$  LSB. This means that for a given input voltage or temperature corresponding to the nearest value in Table 2 and Table 3, the resulting ADC output code will be accurate to the nearest  $\pm 1$  code.

GPIO VIN (V)	CODE
VIN < 0.85	000
0.85 < VIN < 0.90	001
0.90 < VIN < 0.95	010
0.95 < VIN < 1.00	011
1.00 < VIN < 1.05	100
1.05 < VIN < 1.10	101
1.10 < VIN < 1.15	110
1.15 < VIN	111

#### Table 2. ADC Code vs Input Voltage

#### Table 3. ADC Code vs Temperature

TEMPERATURE (°C)	CODE
T < -30	000
−30 < T < −10	001
−10 < T < 15	010
15 < T < 35	011
35 < T < 55	100
55 < T < 75	101
75 < T < 100	110
100 < T	111

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#### 7.3.4.3.1 Programming Example

This section provides an example of configuring the DS90UB935-Q1 and DS90UB936-Q1 for monitoring the voltage on the DS90UB935-Q1 GPIO1 and setting an alarm which results in the INT pin being asserted on the DS90UB936-Q1.

# DS90UB935-Q1 Settings

WriteI2C(0x17,0x3E) # Enable Sensor, Select GPIO1 to sense WriteI2C(0x18,0xB2) # Enable Sensor Gain Setting (Use Default) WriteI2C(0x1A,0x62) # Set Sensor Upper and Lower Limits (Use Default) WriteI2C(0x1D,0x3F) # Enable Sensor Alarms WriteI2C(0x1E,0x7F) # Enable Sending Alarms over BCC

# Register 0x57 readout (bits 2 and 3), indicates if the voltage on the GPIO1 is below or above the thresholds set in the register 0x1A.

# DS90UB936-Q1 Settings

WriteI2C(0x23,0x81) # Enable Interrupts, Enable Interrupts for the camera attached to RX0
WriteI2C(0x4C,0x01) # Enable Writes to RX0 registers
WriteI2C(0xD8,0x08) # Interrupt on change in Sensor Status

# Register 0x51 and 0x52 readouts indicate Sensor data. Register 0x24[7] bit readout indicates the Alarm bit. The alarm bit can be routed to GPI03/INT through GPI0\_PIN\_CTL and GPI0\_OUT\_SRC registers.

#### 7.3.4.4 Built-In Self Test

An optional At-Speed Built-In Self Test (BIST) feature supports testing of the high-speed serial link and back channel without external data connections. This is useful in the prototype stage, equipment production, in-system test, and system diagnostics.

BIST mode is enabled by BIST configuration register 0xB3[0] on the deserializer and should be run in the synchronous mode. When BIST is activated at the deserializer, a BIST enable signal is sent to the serializer through the back channel. The serializer outputs a continuous stream of a pseudo-random sequence and drives the link at speed. The deserializer detects the test pattern and monitors it for errors. The serializer also tracks errors indicated by the CRC fields in each back channel frame. While the lock indications are required to identify the beginning of proper data reception, the best indication of any link failures or data corruption is the content of the error counter in the BIST\_ERR\_COUNT register 0x57 for each RX port on the deserializer side. BIST mode is useful in the prototype stage, equipment production, in-system test, and system diagnostics.

### 7.3.5 FrameSync Operation

When paired with compatible deserializers, any of the DS90UB935-Q1 GPIO pins can be use for frame synchronization. This feature is useful when multiple sensors are connected to a deserializer hub. A frame synchronization signal (FrameSync) can be sent through the back channel using any of the back channel GPIOs. The FrameSync signal arrives at the serializers with limited skew.

#### 7.3.5.1 External FrameSync

In External FrameSync mode, an external signal is input to the deserializer through one of the GPIO pins on the device. The external FrameSync signal may be propagated to one or more of the attached FPD-Link III Serializers through a GPIO signal in the back channel. The expected skew timing for external FrameSync mode is on the order of one back channel frame period or 600 ns when operating at 50 Mbps.

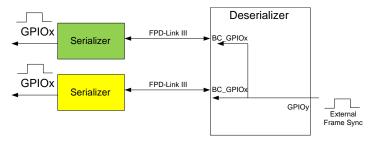


Figure 7. External FrameSync



Enabling the external FrameSync mode is done on the deserializer side. Refer to the deserializer data sheet for more information.

#### 7.3.5.2 Internally Generated FrameSync

In Internal FrameSync mode, an internally generated FrameSync signal is sent to one or more of the attached FPD-Link III Serializers through a GPIO signal in the back channel.

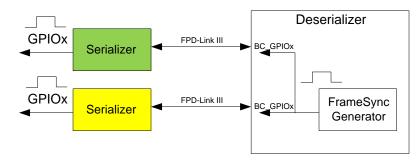


Figure 8. Internal FrameSync

FrameSync operation is controlled by the deserializer registers. Refer to the deserializer data sheet for more information.

#### 7.3.6 GPIO Support

The DS90UB935-Q1 supports four pins, GPIO0 through GPIO3, which can be monitored, configured, and controlled through the I<sup>2</sup>C bus in registers 0x0D, 0x0E, and 0x53. These GPIOs are programmable for use in multiple situations. GPIO0 and GPIO1 have additional diagnostics functionality and may be programmed to sense external voltage levels.

#### 7.3.6.1 GPIO Status

The status HIGH or LOW of each GPIO pin 0 through 3 may be read through the GPIO\_PIN\_STS register 0x53. This register read operation provides the status of the GPIO pin independent of whether the GPIO pin is configured as an input or output.

#### 7.3.6.2 GPIO Input Control

Upon initialization, GPIO0 through GPIO3 are enabled as inputs by default. The GPIO\_INPUT\_CTRL (0x0E) register, bits 3:0, allows control of the input enable. If a GPIO\_INPUT\_CTRL[3:0] bit is set to 1, then the corresponding GPIO\_INPUT\_CTRL[7:4] bit must be set to 0.

#### 7.3.6.3 GPIO Output Control

Individual GPIO output control is programmable through the GPIO\_INPUT\_CTRL (0x0E) register, bits 7:4 Table 25. If a GPIO\_INPUT\_CTRL[7:4] bit is set to 1, then the corresponding GPIO\_INPUT\_CTRL[3:0] bit must be set to 0.



#### 7.3.6.4 Forward Channel GPIO

The input on the DS90UB935-Q1 GPIO pins can be forwarded to compatible deserializers over the FPD-Link III interface. Up to four GPIOs are supported in the forward direction.

The timing for the forward channel GPIO is dependent on the number of GPIOs assigned at the serializer. When a single GPIO input from the DS90UB935-Q1 serializer is linked to a compatible deserializer GPIO output the value is sampled every forward channel transmit frame. Two linked GPIO are sampled every two forward channel frames and three or four linked GPIO are sampled every five frames. The typical minimum latency for the GPIO remains consistent (approximately 225 ns) but as the information gets spread over multiple frames the jitter is typically increased on the order of the sampling period (number of forward channel frames). TI recommends that the user maintains a 4x oversampling ratio for linked GPIO throughput. For example, when operating in 4-Gbps synchronous mode with REFCLK = 25 MHz, the maximum recommended GPIO input frequency based on the number of GPIO linked over the forward channel is shown in Table 4.

NUMBER OF LINKED FORWARD CHANNEL GPIOS (FC_GPIO_EN)	SAMPLING FREQUENCY (MHz) AT FPD-Link III LINE RATE = 4 Gbps	MAXIMUM RECOMMENDED FORWARD CHANNEL GPIO FREQUENCY (MHz)	TYPICAL JITTER (ns)
1	100	25	12
2	50	12.5	24
4	20	5	60

#### Table 4. Forward Channel GPIO Typical Timing

#### 7.3.6.5 Back Channel GPIO

When enabled as an output, each DS90UB935-Q1 GPIO pin can be programed to output remote data coming from the compatible deserializer using the LOCAL\_GPIO\_DATA register (0x0D). The maximum signal frequency that can be received over the FPD-Link III back channel is dependent on the DS90UB935-Q1 Clocking Mode as shown in Table 5.

#### Table 5. Back Channel GPIO Typical Timing

DS90UB935-Q1 Clocking Mode	BACK CHANNEL RATE (Mbps)	SAMPLING FREQUENCY (kHz)	MAXIMUM RECOMMENDED BACK CHANNEL GPIO FREQUENCY (kHz)	TYPICAL LATENCY (µs)	TYPICAL JITTER (μs)
Synchronous Mode	50	1670	416	1.5	0.7
Non-Synchronous Modes	10	334	83.5	3.2	3
DVP Mode	2.5	83.5	20	12.2	12

#### 7.4 Device Functional Modes

#### 7.4.1 Clocking Modes

The DS90UB935-Q1 supports several clocking schemes, which are selected through the MODE pin. In the DS90UB935-Q1, the forward channel operates at a higher bandwidth than the requirement set by the video data being transported, and the forward channel data rate is set by a reference clock. The clocking mode determines what the device uses as its reference clock, and the most common configuration is Synchronous Mode, in which no local reference oscillator is required. See Table 6 for more information.

The default mode of the DS90UB935-Q1 is set by the application of a bias on the MODE pin during power up. More information on setting operation modes can be found in *MODE*.

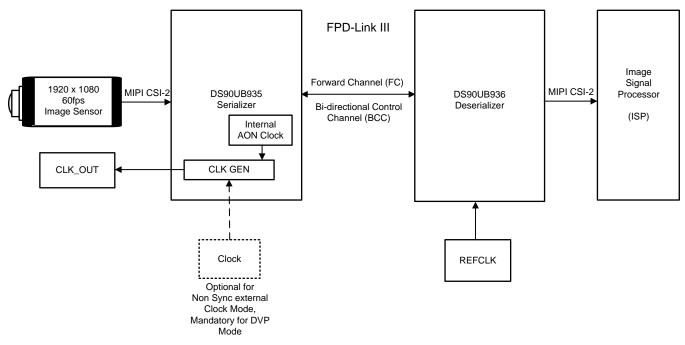


#### **Device Functional Modes (continued)**

Table 6. Clocking Modes								
MODE	DIVIDE	REFERENCE SOURCE	REF FREQUENCY (MHz)	FC DATA RATE	CSI BANDWIDTH ≤	CLK_OUT <sup>(1)</sup>		
Supebropoue	NA	Back Channel <sup>(2)</sup>	23 - 26	f × 160	f × 128	f × 160 / HS_CLK_DIV × (M/N)		
Synchronous	NA	Back Channel <sup>(2)</sup>	11.5 - 13	f × 160	f × 128	f × 160 / HS_CLK_DIV × (M/N)		
Non- Synchronous	CLKIN_DIV=1	Back Channel (Half Rate) <sup>(3)</sup>	25 - 52	f × 80	f × 64	f × 80 / HS_CLK_DIV × (M/N)		
external clock	CLKIN_DIV=2	External clock <sup>(3)</sup>	50 - 104	f × 40	f × 32	f × 40 / HS_CLK_DIV × (M/N)		
Non- Synchronous Internal Clock	CLKIN_DIV=1	935 Internal Clock	24.2 - 25.5	f × 80	f × 64	n/a		
DVP External Clock Deserializer Mode: RAW10	CLKIN_DIV=1	External clock	25 - 66.5	f × 28	f × 20	f × 28 / HS_CLK_DIV × (M/N)		
DVP External Clock Deserializer Mode: RAW12 HF	CLKIN_DIV=1	External clock	25 - 70	f × 28	f × 20	f × 28 / HS_CLK_DIV × (M/N)		

 HS\_CLK\_DIV typically should be set to either 16, 8, or 4 (default).
 The Back Channel is recovered from the FPD-Link III bidirectional control channel. Local reference clock source is not needed. Refer to the Deserializer data sheet for Back Channel frequency settings.

Local reference clock source is needed. Provide a clock source to the DS90UB935-Q1's CLKIN pin. (3)







#### 7.4.1.1 Synchronous Mode

Operation in synchronous mode offers the advantage that the receiver and all of the sensors in a multi-sensor system are locked to a common clock in the same clock domain, which reduces or eliminates the need for data buffering and resynchronization. The synchronous clocking mode also eliminates the cost, space, and potential failure point of a reference oscillator within the sensor module.

In this mode, a clock is passed from the deserializer to the serializer through the FPD-Link III back channel, and the serializer is able to use this clock both as a reference clock for an attached image sensor, and as a reference clock for the link back to the deserializer (FPD-Link III forward channel). For operation in this mode, the DS90UB935-Q1 must be paired with a deserializer that can support this feature such as the DS90UB936-Q1, DS90UB954-Q1, or the DS90UB60-Q1.

#### 7.4.1.2 Non-Synchronous Clock Mode

In the Non-Synchronous Clock mode, the external reference clock is supplied to the serializer, and it uses this clock to derive the FPD-Link III forward channel and an external reference clock for an attached image sensor. When in CSI-2 mode, the CSI-2 interface may be synchronous to this clock. The CSI-2 rate must be lower than the line rate. For example, with a 50-MHz clock the FPD-Link III forward channel rate is 3 Gbps, the CSI-2 throughput must be  $\leq 2.52$  Gbps (See Table 6).

#### 7.4.1.3 Non-Synchronous Internal Mode

In the Non-Synchronous Internal Clocking mode, the serializer uses the internal Always on Clock (AON) as the reference clock for the forward channel. The OSC\_CLK select must be asserted 0x05[3]=1, to enable maximum data rate when using internal clock mode, and the CLK\_OUT function is disabled. A separate reference is provided to the image sensor or ISP. When in CSI-2 mode, the CSI-2 interface may be synchronous to this clock. The CSI-2 rate must be lower than the line rate. For example, with the internal clock of 24.2 MHz the FPD-Link III forward channel rate is 1.936 Gbps, the CSI-2 throughput must be  $\leq 1.55$  Gbps (See Table 6).

#### 7.4.1.4 DVP Backwards Compatibility Mode

The DS90UB935-Q1 can be placed into DVP mode to be backwards compatible with the DS90UB934-Q1 or DS90UB914A-Q1. While the Mode should have been configured using the Mode pin on the DS90UB935-Q1, the register MODE\_SEL register 0x03[2:0] can be used to verify or override the current mode. This field always indicates the MODE setting of the device. When bit 4 of this register is 0, this field is read-only and shows the Mode Setting. Mode is latched from strap value when PDB transitions LOW to HIGH and the value should read back 101 (0x5) if the resistive strap is set correctly to DVP External Clock Backwards Compatible Mode. Alternatively when bit 4 of this register is set to 1, the MODE field is read/write and can be programmed to 101 to assign the correct backwards compatible MODE. This is shown in Table 14.

CSI-2 input data provided to the DS90UB935-Q1 must be synchronized to the input frequency applied to CLKIN when using DVP external clock mode. The PCLK frequency output from the DS90UB934-Q1 or DS90UB914A-Q1 deserializer will also be related to CLKIN when in DVP external clock mode. See *Backwards Compatibility Modes for Operation With Parallel Output Deserializers* (SNLA270) for more information.

REGISTER	REGISTER NAME	REGISTER DESCRIPTION
0X03	MODE_SEL	Used to override and verify strapped value if necessary and configure for DVP with an external clock.
0X04	BC_MODE_SELE CT	Allows DVP mode overwrites to RAW 10 or RAW 12.
0X10	DVP_CFG	Allows configuration of data in DVP mode. This includes data types like long, YUV, and specified types.
0X11	DVP_DT	Allows packets with certain data type regardless of RAW 10 or 12 mode if DVP_DT_MATCH_EN is asserted.

#### Table 7. List of Registers Used for DVP Configuration



#### 7.4.1.5 Configuring CLK\_OUT

When using the DS90UB935-Q1 in either Synchronous or Non-Synchronous external clock modes, CLK\_OUT is intended as a reference clock for the image sensor. CLK\_OUT functionality is disabled when operating in Non-Synchronous internal clocking mode. The frequency of the external CLK\_OUT is set by Equation 1 and Equation 2.

$$CLK\_OUT = FC \times \frac{M}{HS\_CLK\_DIV \times N}$$

where

FC is the forward channel data rate, and M, HS\_CLK\_DIV, and N are parameters set by registers 0x06 and 0x07 (1)

(2)

The PLL that generates CLK\_OUT is a digital PLL, and as such, has very low jitter if the ratio N/M is an integer. If N/M is not an integer, then the jitter on the signal is approximately equal to HS\_CLK\_DIV/FC—so if it is not possible to have an integer ratio of N/M, it is best to select a smaller value for HS\_CLK\_DIV.

If a particular CLK\_OUT frequency such as 37.125 MHz is required for a system, selecting values of M=9, N=0xF2, and HS\_CLK\_DIV=4 results in an output frequency of 37.190 MHz and a frequency error of 0.175% with an associate jitter of approximately 1 ns. Alternately, the designer could use M=1, N=0x1E, HS\_CLK\_DIV=4 for CLK\_OUT = 37.037 MHz, and a frequency error of 0.24% for less jitter. A third alternative would be to use M=1, N=0x1E, and HS\_CLK\_DIV=4, but rather than using a 25.000-MHz reference clock frequency (REFCLK) for the deserializer in synchronous mode, use a frequency of 25.059 MHz. The 2x reference then fed to the DS90UB935-Q1 from the deserializer back channel will allow generating CLK\_OUT = 37.124 MHz with both low jitter and a low frequency error.

#### 7.4.2 MODE

The DS90UB935-Q1 can operate in one of four different modes. The user can apply the bias voltage to the MODE pin during power up to operate in Default mode. To set this voltage, a potential divider between VDDPLL and GND is used to apply the appropriate bias. This potential divider should be referenced to the potential on the VDDD pin. After power up, the MODE can be read or changed through register access.

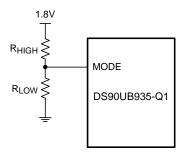


Figure 10. MODE Configuration

MODE

0

2

3

 $5^{(1)}$ 

MODE SELECT

NAME

Synchronous

Non-Synchronous

External Clock

Non-Synchronous

Internal Clock

DVP Mode

0

0.288 x

V<sub>(VDD)</sub>

0.412 x

V<sub>(VDD)</sub>

0 642 x

 $V_{(VDD)}$ 

0

0.325 x

V<sub>(VDD)</sub>

0.443 x

V<sub>(VDD)</sub>

0 673 x

V<sub>(VDD)</sub>

V<sub>(VDD)</sub>

0.367 x

V<sub>(VDD)</sub>

0.474 x

V<sub>(VDD)</sub>

0 704 x

V<sub>(VDD)</sub>

www.ti.com Table 8. Strap Configuration Mode Select V<sub>TARGET</sub> STRAP SUGGESTED STRAP VTARGET VOLTAGE RANGE **RESISTORS (1% TOL)** VOLTAGE DESCRIPTION RATIO RATIO RATIO V<sub>(VDD)</sub> = 1.8 V  $R_{HIGH}$  (k $\Omega$ )  $R_{LOW}$  (k $\Omega$ ) MIN TYP MAX 0.133 x CSI-2 Synchronous mode - FPD-Link III OPEN

75

71.5

39.2

10

35.7

56.2

78.7

FXAS

Clock reference derived from deserializer. CSI-2 Non-synchronous clock - FPD-Link

III Clock reference derived from external

clock reference input on CLKIN pin. CSI-2 Non-synchronous - FPD-Link III

Clock reference derived from internal

AON clock.

DVP with External clock.

**ISTRUMENTS** 

The DS90UB934-Q1 and DS90UB914A-Q1 deserializers also contain a Mode pin (21). However, the mode pin on the deserializer (1) determines the expected data format: RAW10, RAW12 LF, or RAW12 HF. Note that RAW12 LF is not supported on the DS90UB935-Q1.

0

0.586

0.792

1.202

### 7.5 Programming

#### 7.5.1 I<sup>2</sup>C Interface Configuration

This serializer may be configured by the use of an I<sup>2</sup>C-compatible serial control bus. Multiple devices may share the serial control bus (up to two device addresses are supported). The device address is set through a resistor divider (R<sub>HIGH</sub> and R<sub>LOW</sub> – see Figure 11) connected to the IDX pin.

#### 7.5.1.1 CLK OUT/IDX

The CLK\_OUT/IDX pin serves two functions. At power up, the voltage on the IDX pin is compared to VDD and the ratio sets various parameters for configuration of the DS90UB935-Q1. Once the DS90UB935-Q1 has been configured, the CLK\_OUT/IDX pin switches over to a clock source, intended to provide a reference clock to the image sensor. A minimum load impedance at the CLK\_OUT/IDX pin of 35 kΩ is required when using the CLK\_OUT function.

#### 7.5.1.1.1 IDX

The IDX pin configures the control interface to one of two possible device addresses-either the 1.8-V or 3.3-V referenced I<sup>2</sup>C address. A pullup resistor and a pulldown resistor must be used to set the appropriate voltage on the IDX input pin (see Figure 11). The IDX resistor divider must be referred to Pin #25 (after the ferrite filter on the DS90UB935-Q1 pin side).

IDX	V <sub>TARGET</sub> VOLTAGE RANGE		V <sub>TARGET</sub> VOLTAGE RANGE		SUGGESTED STRAP RESISTORS (1% TOL)		I <sup>2</sup> C 8-BIT ADDRES S	I <sup>2</sup> C 7- BIT ADDRE	V <sub>(I2C)</sub> (I2C I/O VOLTAGE)
	RATIO MIN	RATIO TYP	RATIO MAX	V <sub>VDD</sub> = 1.8 V	$R_{HIGH}$ (k $\Omega$ )	$R_{LOW}$ (k $\Omega$ )	3	SS	
1	0	0	0.131 x V <sub>(VDD18)</sub>	0	Open	40.2	0x30	0x18	1.8 V
2	0.178 x V <sub>(VDD18)</sub>	0.214 x V <sub>(VDD18)</sub>	0.256 x V <sub>(VDD18)</sub>	0.385	180	47.5	0x32	0x19	1.8 V
3	0.537 x V <sub>(VDD18)</sub>	0.564 x V <sub>(VDD18)</sub>	0.591 x V <sub>(VDD18)</sub>	1.015	82.5	102	0x30	0x18	3.3 V
4	0.652 x V <sub>(VDD18)</sub>	0.679 x V <sub>(VDD18)</sub>	0.706 x V <sub>(VDD18)</sub>	1.223	68.1	137	0x32	0x19	3.3 V



### Programming (continued)

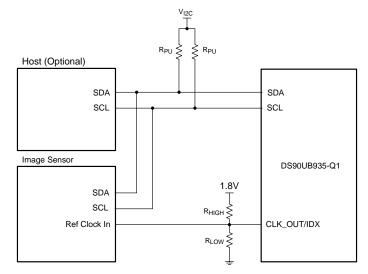


Figure 11. Circuit to Bias IDX Pin

### 7.5.2 I<sup>2</sup>C Interface Operation

The serial control bus consists of two signals: SCL and SDA. SCL is a Serial Bus Clock Input / Output signal and the SDA is the Serial Bus Data Input / Output signal. Both SCL and SDA signals require an external pullup resistor to  $V_{I2C}$ , chosen to be either 1.8 V or 3.3 V.

For the standard and fast I<sup>2</sup>C modes, a pullup resistor  $R_{PU} = 4.7 \text{ k}\Omega$  is recommended, while a pullup resistor  $R_{PU} = 470 \Omega$  is recommended for the fast plus mode. However, the pullup resistor value may be additionally adjusted for capacitive loading and data rate requirements. The signals are either pulled High or driven Low. The IDX pin configures the control interface to one of two possible device addresses. A pullup resistor ( $R_{HIGH}$ ) and a pulldown resistor ( $R_{LOW}$ ) may be used to set the appropriate voltage on the IDX input pin.

The Serial Bus protocol is controlled by START, START-Repeated, and STOP phases. A START occurs when SDA transitions Low while SCL is High. A STOP occurs when SDA transitions High while SCL is also HIGH. See Figure 12.

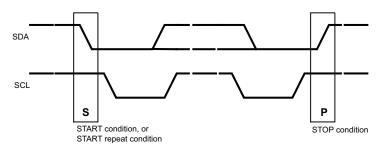


Figure 12. Start and Stop Conditions

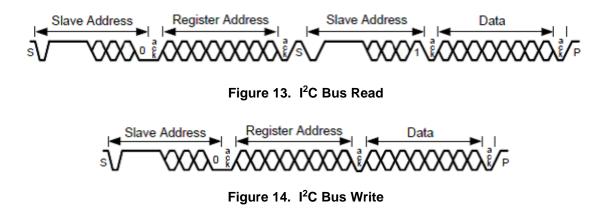
To communicate with an I<sup>2</sup>C slave, the host controller (master) sends the slave address and listens for a response from the slave. This response is referred to as an acknowledge bit (ACK). If a slave on the bus is addressed correctly, the slave Acknowledges (ACKs) the master by driving the SDA bus low. If the address does not match a slave address of the device, the slave Not-acknowledges (NACKs) the master by letting SDA be pulled High. ACKs also occur on the bus when data is being transmitted. When the master is writing data, the slave ACKs after every data byte is successfully received. When the master is reading data, the master ACKs

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#### **Programming (continued)**

after every data byte is received to let the slave know that the master wants to receive another data byte. When the master wants to stop reading, the master NACKs after the last data byte and creates a stop condition on the bus. All communication on the bus begins with either a Start condition or a Repeated Start condition. All communication on the bus ends with a Stop condition. A READ is shown in Figure 13 and a WRITE is shown in Figure 14.



Any I<sup>2</sup>C Master located at the serializer must support I<sup>2</sup>C clock stretching. For more information on I<sup>2</sup>C interface requirements and throughput considerations, refer to TI Application Note I2C Communication Over FPD-Link III with Bidirectional Control Channel (SNLA131).

#### 7.5.3 I<sup>2</sup>C Timing

The proxy master timing parameters are based on the internal reference clock. The I<sup>2</sup>C Master regenerates the I<sup>2</sup>C read or write access using timing controls in the registers 0x0B and 0x0C to regenerate the clock and data signals to meet the desired I<sup>2</sup>C timing in standard, fast, or fast-plus modes of operation.

 $I^2C$  Master SCL High Time is set in register 0x0B. This field configures the high pulse width of the SCL output when the serializer is the master on the local  $I^2C$  bus. The default value is set to provide a minimum 5-µs SCL high time with the internal reference clock at 26.25 MHz including five additional oscillator clock periods or synchronization and response time. Units are 38.1 ns for the nominal oscillator clock frequency, giving Min\_delay = 38.1 ns × (SCL\_HIGH\_TIME + 5).

 $I^2C$  Master SCL Low Time is set in register 0x0C. This field configures the low pulse width of the SCL output when the serializer is the master on the local deserializer  $I^2C$  bus. This value is also used as the SDA setup time by the  $I^2C$  Slave for providing data prior to releasing SCL during accesses over the BiDirectional Control Channel. The default value is set to provide a minimum 5-µs SCL high time with the reference clock at 26.25 MHz including five additional oscillator clock periods or synchronization and response time. Units are 38.1 ns for the nominal oscillator clock frequency, giving Min\_delay = 38.1 ns × (SCL\_HIGH\_TIME + 5). See Table 10 example settings for Standard mode, Fast mode, and Fast Mode Plus timing.

I <sup>2</sup> C MODE	SCL HIGH	TIME	SCL LOW TIME		
FC MODE	0x0B	NOMINAL DELAY	0x0C	NOMINAL DELAY	
Standard	0x7F	5.03 µs	0x7F	5.03 µs	
Fast	0x13	0.914 µs	0x26	1.64 µs	
Fast - Plus	0x06	0.419 µs	0x0B	0.648 µs	

Table 10. Typical I <sup>2</sup> C Timing Register Settings	Table 10.	Typical I <sup>2</sup> C	Timing R	Register	Settings
-------------------------------------------------------------	-----------	--------------------------	----------	----------	----------

#### 7.6 Pattern Generation

The DS90UB935-Q1 supports an internal pattern generation feature to provide a simple way to generate video test patterns for the CSI-2 transmitter outputs. Two types of patterns are supported: Reference Color Bar patterns and Fixed Color patterns accessed by the Pattern Generator page 0 in the indirect register set. See *Indirect Access Registers* for more information on internal registers.



#### 7.6.1 Reference Color Bar Pattern

The CSI-2 Reference pattern provides 8 color bars by default with the following byte data for the color bars: X bytes of 0xAA (high-frequency pattern, inverted), X bytes of 0x33 (mid-frequency pattern), X bytes of 0xF0 (low-frequency pattern, inverted), X bytes of 0x7F (lone 0 pattern), X bytes of 0x55 (high-frequency pattern), X bytes of 0xCC (mid-frequency pattern, inverted), X bytes of 0x0F (low-frequency pattern), and Y bytes of 0x80 (long 1 pattern). In most cases, Y will be the same as X. For certain data types, the last color bar may need to be larger than the others to properly fill the video line dimensions.

The Pattern Generator is programmable with the following options:

- Number of color bars (1, 2, 4, or 8)
- Number of bytes per line
- Number of bytes per color bar
- CSI-2 DataType field and VC-ID
- Number of active video lines per frame
- Number of total lines per frame (active plus blanking)
- Line period (possibly program in units of 10 ns)
- Vertical front porch number of blank lines prior to FrameEnd packet
- Vertical back porch number of blank lines following FrameStart packet

The pattern generator relies on proper programming by software to ensure the color bar widths are set to multiples of the block (or word) size required for the specified DataType. For example, for RGB888, the block size is 3 bytes which also matches the pixel size. In this case, the number of bytes per color bar must be a multiple of 3. The Pattern Generator is implemented in the CSI-2 Transmit clock domain, providing the pattern directly to the CSI-2 Transmitter. The circuit generates the CSI-2 formatted data.

#### 7.6.2 Fixed Color Patterns

When programmed for Fixed Color Pattern mode, the Pattern Generator can generate a video image with a programmable fixed data pattern. The basic programming fields for image dimensions are the same as used with the Color Bar Patterns. When sending Fixed Color Patterns, the color bar controls allow alternating between the fixed pattern data and the bit-wise inverse of the fixed pattern data.

The Fixed Color patterns assume a fixed block size for the byte pattern to be sent. The block size is programmable through a register and is designed to support most 8-bit, 10-bit, and 12-bit pixel formats. The block size should be set based on the pixel size converted to blocks that are an integer multiple of bytes. For example, an RGB888 pattern would consist of 3-byte pixels and therefore require a 3-byte block size. A 2x12-bit pixel image would also require 3-byte block size, while a 3x12-bit pixel image would require 9 bytes (2 pixels) to send an integer number of bytes. Sending a RAW10 pattern typically requires a 5-byte block size for 4 pixels, so 1x10-bit and 2x10-bit could both be sent with a 5-byte block size. For 3x10-bit, a 15-byte block size would be required.

The Fixed Color patterns support block sizes up to 16 bytes in length, allowing additional options for patterns in some conditions. For example, an RGB888 image could alternate between four different pixels by using a twelvebyte block size. An alternating black and white RGB888 image could be sent with a block size of 6-bytes and setting the first three bytes to 0xFF and the next three bytes to 0x00.

To support up to 16-byte block sizes, a set of sixteen registers are implemented to allow programming the value for each data byte.

#### 7.6.3 Packet Generator Programming

The information in this section provides details on how to program the Pattern Generator to provide a specific color bar pattern, based on datatype, frame size, and line size.

DS90UB935-Q1 SNLS605 – JULY 2018



### Pattern Generation (continued)

Most basic configuration information is determined directly from the expected video frame parameters. The requirements should include the datatype, frame rate (frames per second), number of active lines per frame, number of total lines per frame (active plus blanking), and number of pixels per line.

- PGEN\_ACT\_LPF Number of active lines per frame
- PGEN\_TOT\_LPF Number of total lines per frame
- PGEN\_LSIZE Video line length size in bytes. Compute based on pixels per line multiplied by pixel size in bytes
- CSI-2 DataType field and VC-ID.
- Optional: PGEN\_VBP Vertical back porch. This is the number of lines of vertical blanking following Frame Valid.
- Optional: PGEN\_VFP Vertical front porch. This is the number of lines of vertical blanking preceding Frame Valid.
- PGEN\_LINE\_PD Line period in 10-ns units. Compute based on Frame Rate and total lines per frame.
- PGEN\_BAR\_SIZE Color bar size in bytes. Compute based on datatype and line length in bytes (see details below).

#### 7.6.3.1 Determining Color Bar Size

The color bar pattern should be programmed in units of a block or word size dependent on the datatype of the video being sent. The sizes are defined in the MIPI CSI-2 specification. For example, RGB888 requires a 3-byte block size which is the same as the pixel size. RAW10 requires a 5-byte block size which is equal to 4 pixels. RAW12 requires a 3-byte block size which is equal to 2 pixels.

When programming the Pattern Generator, software should compute the required bar size in bytes based on the line size and the number of bars. For the standard 8 color bar pattern, that would require the following algorithm:

- Select the desired datatype, and a valid length for that datatype (in pixels).
- Convert pixels/line to blocks/line (by dividing by the number of pixels/block, as defined in the datatype specification).
- Divide the blocks/line result by the number of color bars (8), giving blocks/bar.
- Round result down to the nearest integer.
- Convert blocks/bar to bytes/bar and program that value into the PGEN\_BAR\_SIZE register.

As an alternative, the blocks/line can be computed by converting pixels/line to bytes/line and dividing by bytes/block.



### Pattern Generation (continued)

#### 7.6.4 Code Example for Pattern Generator

#Patgen RGB888 1920x1080p30 Fixed 8 Colorbar

	Indirect Pattern Gen Registers PGEN_CTL
WriteI2C(0xB1,0x02) # WriteI2C(0xB2,0x33)	PGEN_CFG
WriteI2C(0xB1,0x03) # WriteI2C(0xB2,0x24) #	PGEN_CSI_DI RGB888
WriteI2C(0xB1,0x04) # WriteI2C(0xB2,0x16)	PGEN_LINE_SIZE1
WriteI2C(0xB1,0x05) # WriteI2C(0xB2,0x80)	PGEN_LINE_SIZE0
<pre>WriteI2C(0xB1,0x06) # WriteI2C(0xB2,0x02)</pre>	PGEN_BAR_SIZE1
WriteI2C(0xB2,0xD0)	PGEN_BAR_SIZE0
WriteI2C(0xB2,0x04)	PGEN_ACT_LPF1
WriteI2C(0xB2,0x38)	PGEN_ACT_LPF0
WriteI2C(0xB2,0x04)	PGEN_TOT_LPF1
WriteI2C(0xB2,0x65)	PGEN_TOT_LPF0
WriteI2C(0xB2,0x0B)	PGEN_LINE_PD1
WriteI2C(0xB2,0x93)	PGEN_LINE_PD0
WriteI2C(0xB2,0x21)	PGEN_VEP
<pre>WriteI2C(0xB1,0x0F) # WriteI2C(0xB2,0x0A)</pre>	PGEN_VFP



### 7.7 Register Maps

In the register definitions under the *TYPE* and *DEFAULT* heading, the following definitions apply:

- R = Read only access
- R/W = Read / Write access
- R/RC = Read only access, Read to Clear
- (R/W)/SC = Read / Write access, Self-Clearing bit
- (R/W)/S = Read / Write access, Set based on strap pin configuration at start-up
- LL = Latched Low and held until read
- LH = Latched High and held until read
- S = Set based on strap pin configuration at start-up

#### 7.7.1 I<sup>2</sup>C Device ID Register

#### Table 11. Device ID Register (Address 0x00)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	DEVICE_ID	S, R/W	S	7-bit I2C ID of Serializer. This field always indicates the current value of the I2C ID. When bit 0 of this register is 0, this field is read-only and shows the strapped ID. When bit 0 of this register is 1, this field is read/write and can be used to assign any valid I2C ID.
0	SER_ID_OVERRIDE	R/W	0x0	0: Device ID is from strap 1: Register I <sup>2</sup> C Device ID overrides strapped value

#### 7.7.2 Reset

#### Table 12. RESET\_CTL Register (Address 0x01)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:3	RESERVED	R/W	0x00	Reserved
2	RESTART_AUTOLOAD	(R/W)/SC	0x0	Restart ROM Auto-load Setting this bit to 1 causes a reload of the ROM. This bit is self- clearing.
1	DIGITAL_RESET_1	(R/W)/SC	0x0	Digital Reset 1 Resets the entire digital block including registers. This bit is self- clearing. 1: Reset 0: Normal operation
0	DIGITAL_RESET_0	(R/W)/SC	0x0	Digital Reset 0 Resets the entire digital block except registers. This bit is self- clearing. 1: Reset 0: Normal operation

#### 7.7.3 General Configuration

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved
6	CONTS_CLK	R/W	0x0	CSI-2 Clock Lane Configuration 0 : Non Continuous Clock 1 : Continuous Clock
5:4	CSI_LANE_SEL	R/W	0x3	CSI-2 Data lane configuration 00: 1-lane configuration 01: 2-lane configuration 11: 4-lane configuration
3:2	RESERVED	R/W	0x0	Reserved

#### Table 13. General\_CFG (Address 0x02)

#### DS90UB935-Q1 SNLS605-JULY 2018

Table 13. General\_CFG (Address 0x02) (continued)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
1	CRC_TX_GEN_ ENABLE	R/W	0x1	Transmitter CRC Generator 0: Disable 1: Enable
0	I2C_STRAP_MODE	S, R/W	S	I2C Strap Mode This field indicates the I2C voltage level of the device. Upon device start-up, this field will display the I2C voltage level setting from the strapped IDX pin. This field is write capable and can be used to assign the I2C voltage level. Programming this bit to change the I2C voltage level should only be performed remotely over the back channel from a connected deserializer. 0: 3.3 V 1: 1.8 V

### 7.7.4 Forward Channel Mode Selection

Table 14. WODE_SEL (Address 0.03)							
BIT	FIELD	TYPE	DEFAULT	DESCRIPTION			
7	RESERVED	R/W	0x0	Reserved			
6	RESERVED	S, R	S	Reserved			
5	RESERVED	R/W	0x0	Reserved			
4	MODE_OV	R/W	0x0	<ul><li>0: Serializer Mode from the strapped MODE pin</li><li>1: Register Mode overrides strapped value</li></ul>			
3	MODE_DONE	R	0x0	Indicates MODE value has stabilized and been latched			
2:0	MODE	S, R/W	S	This field always indicates the MODE setting of the device. When bit 4 of this register is 0, this field is read-only and shows the Mode Setting. When bit 4 of this register is 1, this field is read/write and can be used to assign MODE. Mode is latched from strap value when PDB transitions LOW to HIGH. Mode of operation: 000: CSI-2 Synchronous Mode 001: Reserved 010: CSI-2 Non-synchronous external clock Mode (Requires a local clock source) 011: CSI-2 Non-synchronous Internal AON Clock 101: DVP External Clock Backwards Compatible Mode (Requires local clock source)			

### Table 14. MODE\_SEL (Address 0x03)

#### 7.7.5 BC\_MODE\_SELECT

### Table 15. BC\_MODE\_SELECT (Address 0x04)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:3	RESERVED	R/W	0x0	Reserved.
2	MODE_OVERWRITE _100m	R/W	0x0	28-bit RAW 10 Mode operation Backwards compatible RAW 10 DVP mode (28-bit) is automatically configured by the Bidirectional Control Channel once RX lock has been detected. Software may overwrite the value, but must also set the DVP_MODE_OVER_EN to prevent overwriting by the Bidirectional Control Channel
1	MODE_OVERWRITE _75m	R/W	0x0	28-bit RAW 12 Mode operation Backwards compatible RAW 12 HF DVP mode (28-bit) is automatically configured by the Bidirectional Control Channel once RX lock has been detected. Software may overwrite the value, but must also set the DVP_MODE_OVER_EN to prevent overwriting by the Bidirectional Control Channel
0	DVP_MODE_OVER_ EN	R/W	0x0	Prevent auto-loading of the backwards compatible DVP mode (28- bit) operation by the Bidirectional Control Channel



#### 7.7.6 PLL Clock Control

Table 16. PLLCLK_CTRL	Register (Address 0x05)
-----------------------	-------------------------

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved
6:4	CLKIN_DIV	R/W	0x0	CLKIN clock divide ratio to generate internal reference 3'b000 : CLKIN Div by 1 3'b001 : CLKIN Div by 2 3'b010 : CLKIN Div by 4 3'b011 : CLKIN Div by 8 3'b100 - 3'b111 : RESERVED
3	OSCCLK_SEL	R/W	0x0	Internally generated OSC clock reference when operating with Non- Synchronous internal clock or external system clock not detected. 0: 26 MHz ± 5%, set for 2 Gbps line rate 1: 52 MHz ± 5%, set for 3 Gbps line rate in non-synchronous internal clockmode
2:0	RESERVED	R/W	0x3	Reserved

#### 7.7.7 Clock Output Control 0

The DS90UB935-Q1 provides an option for a programmable reference output clock to meet the system clock input requirements of various sensors. The control of the clock output frequency is set by the input divider and M value in register 0x06 and the N value in register 0x07.

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION			
7:5	HS_CLK_DIV	R/W	0x2	Clock source of M/N divider is based on the forward channel data rate divided by this register field. 000: Div by 1 001: Div by 2 010: Div by 4 011: Div by 8 100: Div by 16			
4:0	DIV_M_VAL	R/W	0x01	M value for M/N divider for CLKOUT. CLKOUT can be programmed using the M/N ratio of an internal high-speed clock to generate a clock output based on the system sensor requirement. When selecting the M/N ratio, they should be set to yield the CLKOUT frequency less than 100 MHz. The M value should be $\geq 0$ . If set to 0, the design will get reset the M internally to default of 1.			

#### Table 17. CLKOUT\_CTRL0 (Address 0x06)

#### 7.7.8 Clock Output Control 1

The DS90UB935-Q1 provides option for a programmable reference output clock to meet the system clock input requirements of various sensors. The control of the clock output frequency is set by the input divider and M value in register 0x06 and the N value in register 0x07.

#### Table 18. CLKOUT\_CTRL1 (Address 0x07)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	DIV_N_VAL	R/W	0x28	N value for M/N divider for CLKOUT. CLKOUT can be programmed using the M/N ratio of an internal high-speed clock to generate a clock output based on the system sensor requirement. When selecting the M/N ratio, they should be set to yield the CLKOUT frequency less than 100 MHz. N must be set to non-zero value.



#### 7.7.9 Back Channel Watchdog Control

#### Table 19. BCC\_WATCHDOG (Address 0x08)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	BCC_WD_TIMER	R/W	0x7F	BCC_WD_TIMER sets the Bidirectional Control Channel Watchdog Timeout value in units of 2 milliseconds. This field should not be set to 0. The watchdog timer allows termination of a control channel transaction if it fails to complete within a programmed amount of time.
0	BCC_WD_TIMER_ DISABLE	R/W	0x0	Disable Bidirectional Control Channel Watchdog Timer 1: Disables BCC Watchdog Timer operation 0: Enables BCC Watchdog Timer operation

#### 7.7.10 I2C Control 1

#### Table 20. I2C\_CONTROL1 (Address 0x09)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	LCL_WRITE_ DISABLE	R/W	0x0	Disable Remote Writes to Local Registers Setting this bit to a 1 prevents remote writes to local device registers from across the control channel. This prevents writes to the Serializer registers from an $I^2C$ master attached to the deserializer. Setting this bit does not affect remote access to $I^2C$ slaves at the Serializer.
6:4	I2C_SDA_HOLD	R/W	0x1	Internal SDA Hold Time This field configures the amount of internal hold time provided for the SDA input relative to the SCL input. Units are 50 nanoseconds.
3:0	I2C_FILTER_DEPTH	R/W	0xE	I2C Glitch Filter Depth This field configures the maximum width of glitch pulses on the SCL and SDA inputs that are rejected. Units are 5 nanoseconds.

#### 7.7.11 I2C Control 2

#### TYPE DEFAULT DESCRIPTION BIT FIELD Remote Ack SDA Output Setup When a Control Channel (remote) access is active, this field SDA\_OUTPUT\_ configures setup time from the SDA output relative to the rising edge R/W 7:4 0x1 SETUP of SCL during ACK cycles. Setting this value increases setup time in units of 640 ns. The nominal output setup time value for SDA to SCL when this field is 0 is 80 ns. SDA Output Delay This field configures additional delay on the SDA output relative to the falling edge of SCL. Setting this value increases output delay in units of 40 ns. 3:2 SDA\_OUTPUT\_DELAY R/W 0x0 Nominal output delay values for SCL to SDA are: 00:240 ns 01: 280 ns 10: 320 ns 11: 360 ns Speed up I<sup>2</sup>C Bus Watchdog Timer I2C\_BUS\_TIMER\_ 1 R/W 0x0 1: Watchdog Timer expires after approximately 50 microseconds SPEEDUP 0: Watchdog Timer expires after approximately 1 second. Disable I<sup>2</sup>C Bus Watchdog Timer When the I<sup>2</sup>C Bus Watchdog Timer may be used to detect when the I<sup>2</sup>C bus is free or hung up following an invalid termination of a I2C\_BUS\_TIMER\_ R/W transaction. If SDA is high and no signalling occurs for approximately 0 0x0 DISABLE 1 second, the I<sup>2</sup>C bus is assumed free. If SDA is low and no signaling occurs, the device attempts to clear the bus by driving 9 clocks on SCL.

#### Table 21. I2C\_CONTROL2 (Address 0x0A)

STRUMENTS

EXAS

#### 7.7.12 SCL High Time

#### Table 22. SCL\_HIGH\_TIME (Address 0x0B)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	SCL_HIGH_TIME	R/W	0x7F	$I^2C$ Master SCL High Time This field configures the high pulse width of the SCL output when the Serializer is the Master on the local $I^2C$ bus. Units are 38.1 ns for the nominal oscillator clock frequency of 26.25 MHz. The default value is set to provide a minimum 5-µs SCL high time with the internal oscillator clock running at 26.25 MHz. Delay includes 5 additional oscillator clock periods. Min_delay = 38.0952 ns × (SCL_HIGH_TIME + 5)

#### 7.7.13 SCL Low Time

#### Table 23. SCL\_LOW\_TIME (Address 0x0C)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	SCL_LOW_TIME	R/W	0x7F	I2C SCL Low Time This field configures the low pulse width of the SCL output when the Serializer is the Master on the local I <sup>2</sup> C bus. This value is also used as the SDA setup time by the I <sup>2</sup> C Slave for providing data prior to releasing SCL during accesses over the Bidirectional Control Channel. Units are 38.1 ns for the nominal oscillator clock frequency of 26.25 MHz. The default value is set to provide a minimum 5-µs SCL low time with the internal oscillator clock running at 26.25 MHz. Delay includes 5 additional clock periods. Min_delay = 38.0952 ns × (SCL_LOW_TIME + 5)

#### 7.7.14 Local GPIO DATA

#### Table 24. LOCAL\_GPIO\_DATA (Address 0x0D)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	GPIO_RMTEN	R/W	0xF	Enable remote deserializer GPIO data on local GPIO Bit 7: Enable remote GPIO3 when this bit is set to 1 Bit 6: Enable remote GPIO2 when this bit is set to 1 Bit 5: Enable remote GPIO1 when this bit is set to 1 Bit 4: Enable remote GPIO0 when this bit is set to 1
3:0	GPIO_OUT_SRC	R/W	0x0	GPIO Output Source This register sets the logical output of 4 GPIOs, GPIO_RMTEN must be disabled and GPIOx_OUT_EN must be enabled. Bit 3 write 0/1 on GPIO3 Bit 2 write 0/1 on GPIO2 Bit 1 write 0/1 on GPIO1 Bit 0 write 0/1 on GPIO0

#### 7.7.15 GPIO Input Control

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION				
7	GPIO3_OUT_EN	R/W	0x0	GPIO3 Output Enable 0: Disabled 1: Enabled				
6	GPIO2_OUT_EN	R/W	0x0	GPIO2 Output Enable 0: Disabled 1: Enabled				
5	GPIO1_OUT_EN	R/W	0x0	GPIO1 Output Enable 0: Disabled 1: Enabled				

#### Table 25. GPIO\_INPUT\_CTRL (Address 0x0E)



### Table 25. GPIO\_INPUT\_CTRL (Address 0x0E) (continued)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
4	GPIO0_OUT_EN	R/W	0x0	GPIO0 Output Enable 0: Disabled 1: Enabled
3	GPIO3_INPUT_EN	R/W	0x1	GPIO3 Input Enable 0: Disabled 1: Enabled
2	GPIO2_INPUT_EN	R/W	0x1	GPIO2 Input Enable 0: Disabled 1: Enabled
1	GPIO1_INPUT_EN	R/W	0x1	GPIO1 Input Enable 0: Disabled 1: Enabled
0	GPIO0_INPUT_EN	R/W	0x1	GPIO0 Input Enable 0: Disabled 1: Enabled

### 7.7.16 RESERVED Register

#### Table 26. RESERVED (Address 0x0F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	RESERVED	R	0x0	Reserved.
3:0	RESERVED	R/W	0x0	Reserved.

#### 7.7.17 DVP\_CFG

#### Table 27. DVP\_CFG (Address 0x10)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:5	RESERVED	R/W	0x0	Reserved.
4	DVP_DT_ANY_EN	R/W	0x0	When asserted, allows any packet with a Long data type (DT) packet through DVP.
3	DVP_DT_MATCH_E N	R/W	0x0	When asserted, allows data type matching based on the value in the DVP_DT register. Note: When this bit is asserted, writes to the DVP_DT register are blocked.
2	DVP_DT_YUV_EN	R/W	0x0	When asserted, allows YUV 10-bit DTs through DVP when mode_100m is also asserted (YUV 10-bit DTs are 0x19, 0x1d, and 0x1f).
1	DVP_FV_IN	R/W	0x0	Invert Frame Valid Polarity.
0	DVP_LV_INV	R/W	0x0	Invert Line Valid Polarity.

#### 7.7.18 DVP\_DT

#### Table 28. DVP\_DT (Address 0x11)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	RESERVED	R/W	0x0	Reserved.
5:0	DVP_DT_MATCH_V AL	R/W	0x0	When the DVP_CFG.dvp_dt_match_en is asserted, the DVP block will allow packets with this DT through regardless of the mode_75m or mode_100m setting. The DT value must be a Long DT value (either bit 5 or 4 must be set) for a match to occur.

#### 7.7.19 RESERVED Register

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

### 7.7.20 Force BIST Error

#### Table 30. FORCE\_BIST\_ERR (Address 0x13)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	FORCE_FC_ERR	SC	0x0	FORCE_ERR_CNT allows forcing a number of forward channel parity errors based on the value in FORCE_FC_CNT. When in BIST mode, the parity errors will be generated automatically upon entering BIST mode. When in normal operation this bit must be set to one to inject the parity errors. 0: Force Disabled 1: Force Enabled
6:0	FORCE_FC_CNT	R/W	0x00	Force Error Count. Set this value to the desired number of forced parity errors.

#### 7.7.21 Remote BIST Control

#### Table 31. REMOTE\_BIST\_CTRL (Address 0x14)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	FORCE_ERR_CNT	R/W	0x0	Set to force FC error based on the FORCE_ERR_CNT. 0: Force Disabled 1: Force Enabled
3	LOCAL_BIST_EN	R/W	0x0	Force DS90UB935-Q1 to Enter BIST Mode
2:1	BIST_CLOCK	R/W	0x0	BIST clock source selection 00: External/System clock 01: 50 MHz internal clock 1X: 25 MHz internal clock
0	REMOTE_BIST_EN	R/W	0x0	Backwards-Compatible Remote BIST Enable Register

#### 7.7.22 Sensor Voltage Gain

#### Table 32. SENSOR\_VGAIN (Address 0x15)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved
6:0	VOLT_GAIN	R/W	0x20	Voltage Sensor Gain Setting. VOLT_GAIN = (128 / REG_VALUE) 0x40 = Gain of 2 0x20 = Gain of 4 0x10 = Gain of 8

### 7.7.23 RESERVED Register

#### Table 33. RESERVED (Address 0x16)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x18	Reserved.



# 7.7.24 Sensor Control 0

## Table 34. SENSOR\_CTRL0 (Address 0x17)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	RESERVED	R/W	0x0	Reserved
3:2	SENSOR_ENABLE	R/W	0x3	Temperature and Voltage Sensor Enable 00: Disabled 11: Enabled
1:0	SENSE_V_GPIO	R/W	0x0	Enable GPIO 0/1 for input Voltage Sensor 0/1 measurement 00: No voltage sensing 01: GPIO0 Voltage Sensing 10: GPIO1 Voltage Sensing 11: GPIO0 and GPIO1 Voltage Sensing

# 7.7.25 Sensor Control 1

## Table 35. SENSOR\_CTRL1 (Address 0x18)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	SENSE_GAIN_EN	R/W	0x1	Enable Gain Setting of the Sensor
6:0	RESERVED	R/W	0x00	Reserved

## 7.7.26 Voltage Sensor 0 Thresholds

## Table 36. SENSOR\_V0\_THRESH (Address 0x19)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved
6:4	SENSE_V0_HI	R/W	0x6	GPIO0/V0 sensor upper limit. When the GPIO0 is configured as a voltage sensor, and the voltage measured is above the SENSE_V0_HI, it triggers the V0_SENSOR_HI alarm in the SENSOR_STATUS register.
3	RESERVED	R/W	0x0	Reserved
2:0	SENSE_V0_LO	R/W	0x2	GPIO0/V0 sensor lower limit. When the GPIO0 is configured as a voltage sensor, and the voltage measured is below the SENSE_V0_LO, it triggers the V0_SENSOR_LOW alarm in the SENSOR_STATUS register.

## 7.7.27 Voltage Sensor 1 Thresholds

## Table 37. SENSOR\_V1\_THRESH (Address 0x1A)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved
6:4	SENSE_V1_HI	R/W	0x6	GPIO1/V1 alarm upper limit. When the GPIO1 is configured as a voltage sensor, V1_MAX sets the upper limit for V1_SENSOR_HI status to be triggered
3	RESERVED	R/W	0x0	Reserved
2:0	SENSE_V1_LO	R/W	0x2	GPIO1/V1 alarm lower limit. When the GPIO1 is configured as a voltage sensor, V1_MIN sets the lower limit for V1_SENSOR_LOW status to be triggered

#### 7.7.28 Temperature Sensor Thresholds

#### Table 38. SENSOR\_T\_THRESH (Address 0x1B)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved

# Table 38. SENSOR\_T\_THRESH (Address 0x1B) (continued)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
6:4	SENSE_T_HI	R/W	0x6	Temp sensor upper threshold. When the Temp sensor is enabled, and the temperature measured above the SENSE_T_HI limit, it triggers the T_SENSOR_HI alarm in SENSOR_STATUS.
3	RESERVED	R/W	0x0	Reserved
2:0	SENSE_T_LO	R/W	0x2	Temp sensor lower threshold. When the Temp sensor is enabled, and the temperature measured below the SENSE_T_LO limit, it triggers the T_SENSOR_LOW alarm in SENSOR_STATUS.

## 7.7.29 CSI-2 Alarm Enable

•	Table 39.	ALARM_	_CSI_	EN (	Address	0x1C)	)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	RESERVED	R/W	0x0	Reserved
5	CSI_NO_FV_EN	R/W	0x1	CSI-2 No Frame Valid Alarm Enable 1: Enabled 0: Disabled
4	DPHY_SYNC_ERR_ EN	R/W	0x1	DPHY_SYNC_ERR Alarm Enable 1: Enabled 0: Disabled
3	DPHY_CTRL_ERR_ EN	R/W	0x1	DPHY_CTRL_ERR Alarm Enable 1: Enabled 0: Disabled
2	CSI_ECC_2_EN	R/W	0x1	CSI_ECC2 Alarm Enable 1: Enabled 0: Disabled
1	CSI_CHKSUM_ERR _EN	R/W	0x1	CSI-2 Checksum Error Alarm Enable 1: Enabled 0: Disabled
0	CSI_LENGTH_ERR _EN	R/W	0x1	CSI-2 Length Error Alarm Enable 1: Enabled 0: Disabled

## 7.7.30 Alarm Sense Enable

# Table 40. ALARM\_SENSE\_EN (Address 0x1D)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	RESERVED	R/W	0x0	Reserved
5	T_OVER	R/W	0x0	Enable Temp Sensor over the high limit alarm
4	T_UNDER	R/W	0x0	Enable Temp Sensor under the low limit alarm
3	V1_OVER	R/W	0x0	Enable Voltage1 Sensor over the high limit alarm
2	V1_UNDER	R/W	0x0	Enable Voltage1 Sensor under the low limit alarm
1	V0_OVER	R/W	0x0	Enable Voltage0 Sensor over the high limit alarm
0	V0_UNDER	R/W	0x0	Enable Voltage0 Sensor under the low limit alarm

# 7.7.31 Back Channel Alarm Enable

# Table 41. ALARM\_BC\_EN (Address 0x1E)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:2	RESERVED	R/W	0x00	Reserved
1	CRC_ERR_EN	R/W	0x0	Enable CRC_ERR alarm
0	LINK_DETECT_EN	R/W	0x0	Enable LINK_DETECT alarm

#### 7.7.32 RESERVED Register

Table 42. RESERVED	(Address 0x1F)
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BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

## 7.7.33 CSI-2 Polarity Select

The CSI-2 Polarity Select register allows for changing P/N input polarity for each data lane.

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:5	RESERVED	R	0x0	Reserved
4	POLARITY_CLK0	R/W	0x0	CSI-2 CLK lane 0 Polarity
3	POLARITY_D3	R/W	0x0	CSI-2 Data lane 3 Polarity
2	POLARITY_D2	R/W	0x0	CSI-2 Data lane 2 Polarity
1	POLARITY_D1	R/W	0x0	CSI-2 Data lane 1 Polarity
0	POLARITY_D0	R/W	0x0	CSI-2 Data lane 0 Polarity

#### Table 43. CSI\_POL\_SEL (Address 0x20)

#### 7.7.34 CSI-2 LP Mode Polarity

The CSI-2 LP Mode Polarity register allows for changing polarity for all clocks and data lanes in Low power mode.

## Table 44. CSI\_LP\_POLARITY (Address 0x21)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:5	RESERVED	R/W	0x0	Reserved
4	POL_LP_CLK0	R/W	0x0	LP CSI-2 Clock lane Polarity
3:0	POL_LP_DATA	R/W	0x0	LP CSI-2 Data lane Polarity

## 7.7.35 CSI-2 High-Speed RX Enable

The CSI-2 High Speed RX Enable register is intended for system debugging and should be set to 0x00 for normal operation.

Table 45	. CSI	EN	_HSRX	(Address	0x22)
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BIT	•	FIELD	TYPE	DEFAULT	DESCRIPTION
7		RESERVED	R	0x0	Reserved
6:0		RESERVED	R/W	0x00	Reserved

#### 7.7.36 CSI-2 Low Power Enable

The CSI-2 Low Power Enable register is intended for system debugging.

Table 46. CSI_I	EN_LPRX (Address 0x23)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved
6:0	RESERVED	R/W	0x00	Reserved

## 7.7.37 CSI-2 Termination Enable

The CSI-2 Termination Enable register is intended for system debugging.

#### Table 47. CSI\_EN\_RXTERM (Address 0x24)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	RESERVED	R/W	0x0	Reserved
3	EN_RXTERM_D3	R/W	0x0	Reserved
2	EN_RXTERM_D2	R/W	0x0	Reserved
1	EN_RXTERM_D1	R/W	0x0	Reserved
0	EN_RXTERM_D0	R/W	0x0	Reserved

## 7.7.38 RESERVED Register

## Table 48. RESERVED (Address 0x25)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:4	RESERVED	R/W	0x0	Reserved.
3	RESERVED	R	0x0	Reserved.
2:0	RESERVED	R/W	0x2	Reserved.

## 7.7.39 RESERVED Register

## Table 49. RESERVED (Address 0x26)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:4	RESERVED	R/W	0x0	Reserved.
3	RESERVED	R	0x0	Reserved.
2:0	RESERVED	R/W	0x0	Reserved.

## 7.7.40 RESERVED Register

#### Table 50. RESERVED (Address 0x27)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:3	RESERVED	R	0x00	Reserved.
2:0	RESERVED	R/W	0x0	Reserved.

#### 7.7.41 RESERVED Register

			-	
BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:4	RESERVED	R/W	0x0	Reserved.
3	RESERVED	R	0x0	Reserved.
2:0	RESERVED	R/W	0x7	Reserved.

#### Table 51. RESERVED (Address 0x28)

## 7.7.42 RESERVED Register

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:4	RESERVED	R/W	0x3	Reserved.
3	RESERVED	R	0x0	Reserved.
2:0	RESERVED	R/W	0x3	Reserved.

## Table 52. RESERVED (Address 0x29)

## 7.7.43 RESERVED Register

## Table 53. RESERVED (Address 0x2A)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:4	RESERVED	R/W	0x0	Reserved.
3	RESERVED	R	0x0	Reserved.
2:0	RESERVED	R/W	0x1	Reserved.

## 7.7.44 RESERVED Register

## Table 54. RESERVED (Address 0x2B-0x2D)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:4	RESERVED		0x0	Reserved.
3	RESERVED	R	0x0	Reserved.
2:0	RESERVED		0x0	Reserved.

## 7.7.45 RESERVED Register

## Table 55. RESERVED (Address 0x2E-0x30)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.46 CSI-2 Packet Header Control

#### Table 56. CSI\_PKT\_HDR\_TINIT\_CTRL (Address 0x31)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	PKT_HDR_SEL_ VC	R/W	0x0	For interleaved VC packet select the VC ID to display the packet header. This is effective only if bit4 is set high (PKT_HDR_VCI_ENABLE)
5	PKT_HDR_ CORRECTED	R/W	0x1	<ol> <li>Displays the corrected CSI-2 packet header (in case of error) sent to the receiver</li> <li>Displays the received CSI-2 packet header from imager</li> </ol>
4	PKT_HDR_VCI_ ENABLE	R/W	0x0	Enable the CSI-2 packet header selection based on VC for interleaved mode. For interleaved VC packet set this bit to record the packet headers for each VC. For regular data packet ignore this bit.
3	RESERVED	R/W	0x0	Reserved

## Table 56. CSI\_PKT\_HDR\_TINIT\_CTRL (Address 0x31) (continued)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
2:0	TINIT_TIME	R/W	0x0	CSI-2 Initial Time after power up. Any LP control data are ignored during this time for all CSI-2 lanes. $000 = 100 \ \mu s$ $001 = 200 \ \mu s$ $010 = 300 \ \mu s$ $111 = 800 \ \mu s$ and so forth

# 7.7.47 Back Channel Configuration

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	I2C_PASS_ THROUGH_ALL	R/W	0x0	I2C Pass-Through All Transactions 0: Disabled 1: Enabled
6	I2C_PASS_ THROUGH	R/W	0x0	I2C Pass-Through to Deserializer if decode matches 0: Pass-Through Disabled 1: Pass-Through Enabled
5	AUTO_ACK_ALL	R/W	0x0	Automatically Acknowledge all I2C writes independent of the forward channel lock state or status of the remote Acknowledge 1: Enable 0: Disable
4	RESERVED	R/W	0x0	Reserved
3	RX_PARITY_ CHECKER_ ENABLE	R/W	0x1	Parity Checker Enable 0: Disable 1: Enable
2	RESERVED	R/W	0x0	Reserved
1	RESERVED	R/W	0x0	Reserved
0	RESERVED	R/W	0x1	Reserved

# Table 57. BCC\_CONFIG (Address 0x32)

## 7.7.48 Datapath Control 1

# Table 58. DATAPATH\_CTL1 (Address 0x33)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:3	RESERVED	R/W	0x00	Reserved
2	DCA_CRC_EN	R/W	0x1	DCA CRC Enable If set to a 1, the Forward Channel sends a CRC as part of the DCA sequence. The DCA CRC protects the first 8 bytes of the DCA sequence. The CRC is sent as the 9th byte.
1:0	FC_GPIO_EN	R/W	0x0	Forward Channel GPIO Enable Configures the number of enabled forward channel GPIOs 00: GPIOs disabled 01: One GPIO 10: Two GPIOs 11: Four GPIOs

# 7.7.49 RESERVED Register

# Table 59. RESERVED (Address 0x34)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	RESERVED	R/W	0x0	Reserved.
3	RESERVED	R/W	0x0	Reserved.



SNLS605-JULY 2018

#### Table 59. RESERVED (Address 0x34) (continued)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
2	RESERVED	R/W	0x0	Reserved.
1:0	RESERVED	R/W	0x0	Reserved.

## 7.7.50 Remote Partner Capabilities 1

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	FREEZE_DES_ CAP	R/W	0x0	Freeze Partner Capabilities Prevent auto-loading of the Partner Capabilities by the Bidirectional Control Channel. The Capabilities are frozen at the values written in registers 0x1E and 0x1F.
6	RESERVED	R/W	0x0	Reserved
5	BIST_EN	R/W	0x0	Link BIST Enable This bit indicates the remote partner is requesting BIST operation over the FPD-Link III interface. This field is automatically configured by the Bidirectional Control Channel once back channel link has been detected. Software may overwrite this value, but must also set the FREEZE_DES_CAP bit to prevent overwriting by the Bidirectional Control Channel.
4	MPORT	R/W	0x0	Remote Partner Multi-Port capable 0 : Remote partner is a single-port deserializer device 1 : Remote partner is a multi-port deserializer device This field is automatically configured by the Bidirectional Control Channel once back channel link has been detected. Software may overwrite this value, but must also set the FREEZE_DES_CAP bit to prevent overwriting by the Bidirectional Control Channel.
3:0	PORT_NUM	R/W	0x0	Remote Partner port number When connected to a multi-port device, this field indicates the port number to which the Serializer is connected. This field is automatically configured by the Bidirectional Control Channel once back channel link has been detected. Software may overwrite this value, but must also set the FREEZE_DES_CAP bit to prevent overwriting by the Bidirectional Control Channel.

## Table 60. REMOTE\_PAR\_CAP1 (Address 0x35)

## 7.7.51 RESERVED Register

## Table 61. RESERVED (Address 0x36)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

## 7.7.52 Partner Deserializer ID

#### Table 62. DES\_ID (Address 0x37)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	DES_ID	R/W	0x3D	Remote Deserializer ID This field is normally loaded automatically from the remote Deserializer.
0	FREEZE_ DEVICE_ID	R/W	0x0	Freeze Deserializer Device ID Prevent auto-loading of the Deserializer Device ID from the back channel. The ID is frozen at the value written.

## 7.7.53 RESERVED Register

Table 63. F	RESERVED	(Address	0x38)
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BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

# 7.7.54 Slave 0 ID

#### Table 64. SLAVE\_ID\_0 (Address 0x39)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_0	R/W	0x00	7-bit Remote Slave Device ID 0 Configures the physical $I^2C$ address of the remote $I^2C$ Slave device attached to the remote Deserializer. If an $I^2C$ transaction is addressed to the Slave Alias ID0, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer.
0	RESERVED	R	0x0	Reserved

#### 7.7.55 Slave 1 ID

## Table 65. SLAVE\_ID\_1 (Address 0x3A)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_1	R/W	0x00	7-bit Remote Slave Device ID 1 Configures the physical $I^2C$ address of the remote $I^2C$ Slave device attached to the remote Deserializer. If an $I^2C$ transaction is addressed to the Slave Alias ID1, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer
0	RESERVED	R	0x0	Reserved

## 7.7.56 Slave 2 ID

## Table 66. SLAVE\_ID\_2 (Address 0x3B)

BIT	Г	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	I	SLAVE_ID_2	R/W	0x00	7-bit Remote Slave Device ID 2 Configures the physical I <sup>2</sup> C address of the remote I <sup>2</sup> C Slave device attached to the remote Deserializer. If an I <sup>2</sup> C transaction is addressed to the Slave Alias ID2, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer.
0		RESERVED	R	0x0	Reserved

## 7.7.57 Slave 3 ID

0

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_3	R/W	0x00	7-bit Remote Slave Device ID 3 Configures the physical I <sup>2</sup> C address of the remote I <sup>2</sup> C Slave device attached to the remote Deserializer. If an I <sup>2</sup> C transaction is addressed to the Slave Alias ID3, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer.

## Table 67. SLAVE\_ID\_3 (Address 0x3C)

RESERVED

R

0x0

Reserved



## 7.7.58 Slave 4 ID

## Table 68. SLAVE\_ID\_4 (Address 0x3D)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_4	R/W	0x00	7-bit Remote Slave Device ID 4 Configures the physical $I^2C$ address of the remote $I^2C$ Slave device attached to the remote Deserializer. If an $I^2C$ transaction is addressed to the Slave Alias ID4, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer.
0	RESERVED	R	0x0	Reserved

#### 7.7.59 Slave 5 ID

## Table 69. SLAVE\_ID\_5 (Address 0x3E)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_5	R/W	0x00	7-bit Remote Slave Device ID 5 Configures the physical $I^2C$ address of the remote $I^2C$ Slave device attached to the remote Deserializer. If an $I^2C$ transaction is addressed to the Slave Alias ID5, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer.
0	RESERVED	R	0x0	Reserved

## 7.7.60 Slave 6 ID

## Table 70. SLAVE\_ID\_6 (Address 0x3F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_6	R/W	0x00	7-bit Remote Slave Device ID 6 Configures the physical I <sup>2</sup> C address of the remote I <sup>2</sup> C Slave device attached to the remote Deserializer. If an I <sup>2</sup> C transaction is addressed to the Slave Alias ID6, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer.
0	RESERVED	R	0x0	Reserved

#### 7.7.61 Slave 7 ID

## Table 71. SLAVE\_ID\_7 (Address 0x40)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_7	R/W	0x00	7-bit Remote Slave Device ID 7 Configures the physical $I^2C$ address of the remote $I^2C$ Slave device attached to the remote Deserializer. If an $I^2C$ transaction is addressed to the Slave Alias ID7, the transaction is remapped to this address before passing the transaction across the Bidirectional Control Channel to the Deserializer.
0	RESERVED	R	0x0	Reserved

# 7.7.62 Slave 0 Alias

## Table 72. SLAVE\_ID\_ALIAS\_0 (Address 0x41)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_ ALIAS_0	R/W	0x00	7-bit Remote Slave Device Alias ID 0 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID0 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.

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## Table 72. SLAVE\_ID\_ALIAS\_0 (Address 0x41) (continued)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
0	SLAVE_AUTO_ ACK_0	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 0 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.

## 7.7.63 Slave 1 Alias

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_ALIAS _1	R/W	0x00	7-bit Remote Slave Device Alias ID 1 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID1 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.
0	SLAVE_AUTO_ ACK_1	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 1 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.

# Table 73. SLAVE\_ID\_ALIAS\_1 (Address 0x42)

## 7.7.64 Slave 2 Alias

## Table 74. SLAVE\_ID\_ALIAS\_2 (Address 0x43)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_ALIAS _2	R/W	0x00	7-bit Remote Slave Device Alias ID 2 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID2 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.
0	SLAVE_AUTO_ ACK_2	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 2 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.

## 7.7.65 Slave 3 Alias

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_ALIAS _3	R/W	0x00	7-bit Remote Slave Device Alias ID 3 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID3 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.
0	SLAVE_AUTO_ ACK_3	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 3 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.

## Table 75. SLAVE\_ID\_ALIAS\_3 (Address 0x44)



## 7.7.66 Slave 4 Alias

## Table 76. SLAVE\_ID\_ALIAS\_4 (Address 0x45)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_ALIAS _4	R/W	0x00	7-bit Remote Slave Device Alias ID 4 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID4 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.
0	SLAVE_AUTO_ ACK_4	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 4 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.

# 7.7.67 Slave 5 Alias

## Table 77. SLAVE\_ID\_ALIAS\_5 (Address 0x46)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_ALIAS _5	R/W	0x00	7-bit Remote Slave Device Alias ID 5 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID5 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.
0	SLAVE_AUTO_ ACK_5	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 5 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.

## 7.7.68 Slave 6 Alias

# Table 78. SLAVE\_ID\_ALIAS\_6 (Address 0x47)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	SLAVE_ID_ALIAS _6	R/W	0x00	7-bit Remote Slave Device Alias ID 6 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID6 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.
0	SLAVE_AUTO_ ACK_6	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 6 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.



DS90UB935-Q1 SNLS605 – JULY 2018

## 7.7.69 Slave 7 Alias

#### Table 79. SLAVE\_ID\_ALIAS\_7 (Address 0x48)

BIT	FIELD	TYPE	DEFAUL T	DESCRIPTION
7:1	SLAVE_ID_ALIAS _7	R/W	0x00	7-bit Remote Slave Device Alias ID 7 Configures the decoder for detecting transactions designated for an $I^2C$ Slave device attached to the remote Deserializer. The transaction is remapped to the address specified in the Slave ID7 register. A value of 0 in this field disables access to the remote $I^2C$ Slave.
0	SLAVE_AUTO_ ACK_7	R/W	0x0	Automatically Acknowledge all I2C writes to the remote Slave 7 independent of the forward channel lock state or status of the remote Deserializer Acknowledge 1: Enable 0: Disable This is intended for debugging only and not recommended for normal operation.

## 7.7.70 Back Channel Control

	,							
BIT	FIELD	TYPE	DEFAUL T	DESCRIPTION				
7:6	RESERVED	R	0x0	Reserved				
5	BIST_CRC_ERR _CLR	(R/W)/SC	0x0	Clear BIST CRC error counter 0: Disable clear 1: Enable Clear				
4	RESERVED	R/W	0x0	Reserved				
3	CRC_ERR_CLR	(R/W)/SC	0x0	Clear CRC error 0: Disable clear 1: Enable clear				
2:0	LINK_DET_ TIMER	R/W	0x0	TX-RX link detect timer val				

## Table 80. BC\_CTRL (Address 0x49)

## 7.7.71 Revision ID

# Table 81. REV\_MASK\_ID (Address 0x50)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	REVISION_ID	R	0x2	Revision ID
3:0	MASK_ID	R	0x0	Mask ID

#### 7.7.72 Device Status

BIT	FIELD	TYPE	DEFAUL T	DESCRIPTION
7	CFG_CKSUM_ STS	R	0x0	Config Checksum Passed This bit is set following initialization if the Configuration data in the eFuse ROM had a valid checksum
6	CFG_INIT_DONE	R	0x0	Power-up initialization complete This bit is set after Initialization is complete. Configuration from eFuse ROM has completed.
5:0	RESERVED	R	0x00	Reserved

## Table 82. Device STS (Address 0x51)



## 7.7.73 General Status

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved
6	RX_LOCK_ DETECT	R	0x0	Deserializer LOCK status This bit indicates the LOCK status of the Deserializer.
5	RESERVED	R	0x0	Reserved
4	LINK_LOST_ FLAG	R	0x0	Back Channel Link lost Status changed This bit is set if a change in BC LINK DET lost status has been detected. This bit is cleared upon read of CRC ERR CLR register or HS PLL loses lock.
3	BIST_CRC_ERR	R	0x0	BIST Error is detected. The BIST_ERR_CNT register contain the number of Back Channel BIST errors.
2	HS_PLL_LOCK	R	0x1	Forward Channel High speed PLL lock flag
1	CRC_ERR	R	0x0	Back Channel CRC error detected This bit is set when the back channel errors detected when BC LINK DET is asserted. This bit is cleared upon read of CRC_ERR_CLR register.
0	LINK_DET	R	0x1	Back Channel Link detect This bit is set when BC link is valid.

#### Table 83. GENERAL\_STATUS (Address 0x52)

## 7.7.74 GPIO Pin Status

#### Table 84. GPIO\_PIN\_STS (Address 0x53)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	RESERVED	R	0x0	Reserved
3:0	GPIO_STS	R	0x0	GPIO Pin Status This register reads the current values on GPIO pins. Bit 3 reads GPIO3 pin status Bit 2 reads GPIO2 pin status Bit 1 reads GPIO1 pin status Bit 0 reads GPIO0 pin status

## 7.7.75 BIST Error Count

#### Table 85. BIST\_ERR\_CNT (Address 0x54)

	BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
ſ	7:0	BIST_BC_ ERRCNT	R	0x00	CRC error count in BIST mode.

## 7.7.76 CRC Error Count 1

#### Table 86. CRC\_ERR\_CNT1 (Address 0x55)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	CRC_ERR_CNT1	R	0x00	CRC Error count (LSB)

# 7.7.77 CRC Error Count 2

#### Table 87. CRC\_ERR\_CNT2 (Address 0x56)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	CRC_ERR_CNT2	R	0x00	CRC Error count (MSB)

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DS90UB935-Q1 SNLS605 – JULY 2018

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## 7.7.78 Sensor Status

## Table 88. SENSOR\_STATUS (Address 0x57)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	RESERVED	R	0x0	Reserved
5	T_SENSOR_HI	R	0x0	When set, this bit indicates that GPIO0 Sensor is above SENSE_T_HI limit. This bit is cleared upon read.
4	T_SENSOR_ LOW	R	0x0	When set, this bit indicates that GPIO0 Sensor is below SENSE_T_LO limit. This bit is cleared upon read.
3	V1_SENSOR_ HI	R	0x0	When set, this bit indicates that GPIO1 input is above SENSE_V1_HI limit. This bit is cleared upon read.
2	V1_SENSOR_ LOW	R	0x0	When set, this bit indicates that GPIO1 input is below SENSO_V1_LO limit. This bit is cleared upon read.
1	V0_SENSOR_ HI	R	0x0	When set, this bit indicates that GPIO0 input is above SENSE_V0_HI limit. This bit will be cleared upon read.
0	V0_SENSOR_ LOW	R	0x0	When set, this bit indicates that GPIO0 input is below SENSO_V0_LO limit. This bit will be cleared upon read.

## 7.7.79 Sensor V0

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION				
7	RESERVED	R/W	0x0	Reserved				
6:4	VOLTAGE_ SENSOR_V0_ MAX	RC	0x0	GPIO0 Voltage sensor max reading when the GPIO0 voltage is above SENSE_V0_HI limit. This bit is cleared upon read. 0 indicates alarm has not been triggered.				
3	RESERVED	R/W	0x0	Reserved				
2:0	VOLTAGE_ SENSOR_V0_ MIN	RC	0x7	GPIO0 Voltage sensor min reading when GPIO0 voltage is below SENSE_V0_LO limit. This bit is cleared upon read. 7 indicates alarm has not been triggered.				

# Table 89. SENSOR\_V0 (Address 0x58)

#### 7.7.80 Sensor V1

## Table 90. SENSOR\_V1 (Address 0x59)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved
6:4	VOLTAGE_ SENSOR_V1_ MAX	RC	0x0	GPIO1 Voltage sensor max reading when the GPIO1 voltage is above SENSE_V1_HI limit. This bit is cleared upon read. 0 indicates alarm has not been triggered.
3	RESERVED	R/W	0x0	Reserved
2:0	VOLTAGE_ SENSOR_V1_ MIN	RC	0x7	GPIO1 Voltage sensor min reading when GPIO1 voltage is below SENSE_V1_LO limit. This bit is cleared upon read. 7 indicates alarm has not been triggered.

## 7.7.81 Sensor T

## Table 91. SENSOR\_T (Address 0x5A)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved
6:4	TEMP_MAX	RC	0x0	Internal Temperature sensor maximum reading when temperature is above SENSE_T_HI limit. This bit is cleared upon read. 0 indicates alarm has not been triggered.



## Table 91. SENSOR\_T (Address 0x5A) (continued)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
3	RESERVED	R/W	0x0	Reserved
2:0	TEMP_MIN	RC	0x7	Internal Temperature sensor minimum reading when temperature is below SENSE_T_LO limit. This bit is cleared upon read. 7 indicates alarm has not been triggered.

## 7.7.82 RESERVED Register

## Table 92. RESERVED (Address 0x5B)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:2	RESERVED	R/W	0x00	Reserved.
1	RESERVED	RC	0x0	Reserved.
0	RESERVED	RC	0x0	Reserved.

## 7.7.83 CSI-2 Error Count

## Table 93. CSI\_ERR\_CNT (Address 0x5C)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	CSI_ERR_CNT	RC	0x00	CSI-2 Error Counter Register This register counts the number of CSI-2 packets received with errors since the last read of the counter.

#### 7.7.84 CSI-2 Error Status

### Table 94. CSI\_ERR\_STATUS (Address 0x5D)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	RESERVED	R	0x0	Reserved
3	LINE_LEN_ MISMATCH	R/RC	0x0	Indicates Line length less than the received Packet header Word count
2	CHKSUM_ERR	R/RC	0x0	Indicates a checksum error detected in the incoming data (uncorrectable)
1	ECC_2BIT_ERR	R/RC	0x0	Indicates a 2-Bit Ecc error (uncorrectable) in the Packet header
0	ECC_1BIT_ERR	R/RC	0x0	Indicates a 1-Bit Ecc error detected in the Packet header

## 7.7.85 CSI-2 Errors Data Lanes 0 and 1

## Table 95. CSI\_ERR\_DLANE01 (Address 0x5E)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION		
7	SOT_ERROR_1	R	0x0	Lane 1: Single-bit Error in SYNC Sequence - Correctable		
6	SOT_SYNC_ ERROR_1	R	0x0	Lane 1: Multi-bit Error in SYNC Sequence - Uncorrectable		
5	CNTRL_ERR_ HSRQST_1	R	0x0	Lane 1: Control Error in HS Request Mode		
4	RESERVED	R	0x0	Reserved		
3	SOT_ERROR_0	R	0x0	Lane 0: Single-bit Error in SYNC Sequence - Correctable		
2	SOT_SYNC_ ERROR_0	R	0x0	Lane 0: Multi-bit Error in SYNC Sequence - Uncorrectable		
1	CNTRL_ERR_ HSRQST_0	R	0x0	Lane 0: Control Error in HS Request Mode		
0	RESERVED	R	0x0	Reserved		

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## 7.7.86 CSI-2 Errors Data Lanes 2 and 3

#### Table 96. CSI\_ERR\_DLANE23 (Address 0x5F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	SOT_ERROR_3	R	0x0	Lane 3: Single-bit Error in SYNC Sequence - Correctable
6	SOT_SYNC_ ERROR_3	R	0x0	Lane 3: Multi-bit Error in SYNC Sequence - Uncorrectable
5	CNTRL_ERR_ HSRQST_3	R	0x0	Lane 3: Control Error in HS Request Mode
4	RESERVED	R	0x0	Reserved
3	SOT_ERROR_2	R	0x0	Lane 2: Single-bit Error in SYNC Sequence - Correctable
2	SOT_SYNC_ ERROR_2	R	0x0	Lane 2: Multi-bit Error in SYNC Sequence - Uncorrectable
1	CNTRL_ERR_ HSRQST_2	R	0x0	Lane 2: Control Error in HS Request Mode
0	RESERVED	R	0x0	Reserved

## 7.7.87 CSI-2 Errors Clock Lane

#### Table 97. CSI\_ERR\_CLK\_LANE (Address 0x60)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:2	RESERVED	R	0x00	Reserved
1	CNTRL_ERR_ HSRQST_CK0	R	0x0	Clk Lane: Control Error in HS Request Mode
0	RESERVED	R	0x0	Reserved

## 7.7.88 CSI-2 Packet Header Data

## Table 98. CSI\_PKT\_HDR\_VC\_ID (Address 0x61)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	LONG_PKT_ VCHNL_ID	R	0x0	Virtual Channel ID from CSI-2 Packet header
5:0	LONG_PKT_ DATA_ID	R	0x00	Data ID from CSI-2 Packet header

## 7.7.89 Packet Header Word Count 0

## Table 99. PKT\_HDR\_WC\_LSB (Address 0x62)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	LONG_PKT_ WRD_CNT_ LSB	R	0x00	Payload count lower byte from CSI-2 Packet header

#### 7.7.90 Packet Header Word Count 1

## Table 100. PKT\_HDR\_WC\_MSB (Address 0x63)

В	BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	7:0	LONG_PKT_ WRD_CNT_ MSB	R	0x00	Payload count upper byte from CSI-2 Packet header

## Table 101. CSI\_ECC (Address 0x64)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	LINE_ LENGTH_ CHANGE	R	0x0	Indicates Line length change detected per frame
6	RESERVED	R	0x0	Reserved
5:0	CSI-2_ECC	R	0x00	CSI-2 ECC byte from packet header

## 7.7.92 RESERVED Register

## Table 102. RESERVED (Address 0x65-67)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R	0x00	Reserved.

#### 7.7.93 RESERVED Register

#### Table 103. RESERVED (Address 0x68-6F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED		0x00	Reserved.

## 7.7.94 RESERVED Register

## Table 104. RESERVED (Address 0x70-0x71)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

# 7.7.95 RESERVED Register

#### Table 105. RESERVED (Address 0x72)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x25	Reserved.

## 7.7.96 RESERVED Register

#### Table 106. RESERVED (Address 0x73)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.97 RESERVED Register

#### Table 107. RESERVED (Address 0x74)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:4	RESERVED		0x0	Reserved.
3:0	RESERVED	R/W	0x0	Reserved.

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## 7.7.98 RESERVED Register

## Table 108. RESERVED (Address 0x75)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	RESERVED	R/W	0x00	Reserved.
0	RESERVED		0x0	Reserved.

#### 7.7.99 RESERVED Register

#### Table 109. RESERVED (Address 0x76)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R/W	0x0	Reserved.
6:4	RESERVED	R	0x0	Reserved.
3:0	RESERVED	R/W	0x0	Reserved.

#### 7.7.100 RESERVED Register

## Table 110. RESERVED (Address 0x77)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.101 RESERVED Register

# Table 111. RESERVED (Address 0x78)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6	RESERVED	SC	0x0	Reserved.
5:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.102 RESERVED Register

#### Table 112. RESERVED (Address 0x79)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:5	RESERVED	R/W	0x0	Reserved.
4:0	RESERVED	R/RC	0x00	Reserved.

#### 7.7.103 RESERVED Register

#### Table 113. RESERVED (Address 0x7A)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x04	Reserved.

## 7.7.104 RESERVED Register

#### Table 114. RESERVED (Address 0x7B-0x85)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.



#### 7.7.105 RESERVED Register

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x90	Reserved.

#### 7.7.106 RESERVED Register

#### Table 116. RESERVED (Address 0x87-0x88)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.107 RESERVED Register

#### Table 117. RESERVED (Address 0x89-0x8B)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R	0x00	Reserved.

#### 7.7.108 RESERVED Register

#### Table 118. RESERVED (Address 0x8C-0x8F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

## 7.7.109 RESERVED Register

#### Table 119. RESERVED (Address 0x90)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED		0x0	Reserved.
6	RESERVED	R/W	0x0	Reserved.
5:0	RESERVED	R/W	0x32	Reserved.

## 7.7.110 RESERVED Register

#### Table 120. RESERVED (Address 0x91)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0xE2	Reserved.

#### 7.7.111 RESERVED Register

#### Table 121. RESERVED (Address 0x92)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	RESERVED	R	0x0	Reserved.
6:0	RESERVED	R/W	0x64	Reserved.

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## 7.7.112 RESERVED Register

### Table 122. RESERVED (Address 0x93)

E	BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
-	7:0	RESERVED	R/W	0x01	Reserved.

## 7.7.113 RESERVED Register

#### Table 123. RESERVED (Address 0x94-0x99)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.114 RESERVED Register

#### Table 124. RESERVED (Address 0x9A-0x9E)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	RESERVED	R	0x0	Reserved.
5:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.115 RESERVED Register

#### Table 125. RESERVED (Address 0x9F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:5	RESERVED	R	0x0	Reserved.
4:0	RESERVED	R/W	0x10	Reserved.

#### 7.7.116 RESERVED Register

#### Table 126. RESERVED (Address 0xA0)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED		0x0	Reserved.

#### 7.7.117 RESERVED Register

#### Table 127. RESERVED (Address 0xA1-0xA4)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:5	RESERVED	R	0x0	Reserved.
4:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.118 RESERVED Register

## Table 128. RESERVED (Address 0xA5)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x10	Reserved.



# 7.7.119 RESERVED Register

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x42	Reserved.

#### 7.7.120 RESERVED Register

#### Table 130. RESERVED (Address 0xA7-0xA9)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x10	Reserved.

## 7.7.121 RESERVED Register

# Table 131. RESERVED (Address 0xAA-0xAB)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R/W	0x00	Reserved.

#### 7.7.122 RESERVED Register

#### Table 132. RESERVED (Address 0xAC-0xAF)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED		0x00	Reserved.

## 7.7.123 IND\_ACC\_CTL

# Table 133. IND\_ACC\_CTL (Address 0xB0) DEFAULT DESCRIPTION

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:5	RESERVED	R	0x0	Reserved
4:2	IA_SEL	R/W	0x0	Indirect Register Select: Selects target for register access 000 : PATGEN 001 : FPD3 TX Registers 010: DIE ID Data
1	IA_AUTO_INC	R/W	0x0	Indirect Access Auto Increment: Enables auto-increment mode. Upon completion of a read or write, the register address is automatically incremented by 1
0	IA_READ	R/W	0x0	Indirect Access Read: Setting this allows generation of a read strobe to the selected register block upon setting of the IND_ACC_ADDR register. In auto-increment mode, read strobes are also asserted following a read of the IND_ACC_DATA register. This function is only required for blocks that need to pre-fetch register data.

#### 7.7.124 IND\_ACC\_ADDR

#### Table 134. IND\_ACC\_ADDR (Address 0xB1)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	IND_ACC_ ADDR	R/W	0x00	Indirect Access Register Offset: This register contains the 8-bit register offset for the indirect access.

## 7.7.125 IND\_ACC\_DATA

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	IND_ACC_ DATA	R/W	0x00	Indirect Access Register Data: Writing this register causes an indirect write of the IND_ACC_DATA value to the selected analog block register. Reading this register returns the value of the selected analog block register.

#### Table 135. IND\_ACC\_DATA (Address 0xB2)

#### 7.7.126 RESERVED Register

#### Table 136. RESERVED (Address 0xB3-0xEF)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R	0x00	Reserved.

#### 7.7.127 FPD3\_RX\_ID0

#### Table 137. FPD3\_RX\_ID0 (Address 0xF0)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	FPD3_RX_ ID0	R	0x5F	FPD3_TX_ID0: First byte ID code: '_'

## 7.7.128 FPD3\_RX\_ID1

#### Table 138. FPD3\_RX\_ID1 (Address 0xF1)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	FPD3_RX_ ID1	R	0x55	FPD3_TX_ID1: 2nd byte of ID code: 'U'

## 7.7.129 FPD3\_RX\_ID2

#### Table 139. FPD3\_RX\_ID2 (Address 0xF2)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	FPD3_RX_ ID2	R	0x42	FPD3_TX_ID2: 3rd byte of ID code: 'B'

#### 7.7.130 FPD3\_RX\_ID3

#### Table 140. FPD3\_RX\_ID3 (Address 0xF3)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	FPD3_RX_ ID3	R	0x39	FPD3_TX_ID3: 4th byte of ID code: '9'

## 7.7.131 FPD3\_RX\_ID4

## Table 141. FPD3\_RX\_ID4 (Address 0xF4)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	FPD3_RX_ ID4	R	0x35	FPD3_TX_ID4: 5th byte of ID code: '5'



# 7.7.132 FPD3\_RX\_ID5

# Table 142. FPD3\_RX\_ID5 (Address 0xF5)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	FPD3_RX_ ID5	R	0x33	FPD3_TX_ID5: 6th byte of ID code: '3'



#### 7.7.133 Indirect Access Registers

Several functional blocks include register sets contained in the Indirect Access map (Table 143); that is, Pattern Generator, and Analog controls. Register access is provided through an indirect access mechanism through the Indirect Access registers (IND\_ACC\_CTL, IND\_ACC\_ADDR, and IND\_ACC\_DATA). These registers are located at offsets 0xB0-0xB2 in the main register space.

The indirect address mechanism involves setting the control register to select the desired block, setting the register offset address, and reading or writing the data register. In addition, an auto-increment function is provided in the control register to automatically increment the offset address following each read or write of the data register.

For writes, the process is as follows:

- 1. Write to the IND\_ACC\_CTL register to select the desired register block
- 2. Write to the IND\_ACC\_ADDR register to set the register offset
- 3. Write the data value to the IND\_ACC\_DATA register

If auto-increment is set in the IND\_ACC\_CTL register, repeating step 3 writes additional data bytes to subsequent register offset locations.

For reads, the process is as follows:

- 1. Write to the IND\_ACC\_CTL register to select the desired register block
- 2. Write to the IND\_ACC\_ADDR register to set the register offset
- 3. Read from the IND\_ACC\_DATA register

If auto-increment is set in the IND\_ACC\_CTL register, repeating step 3 reads additional data bytes from subsequent register offset locations.

IA SELECT 0xB0[4:2]	PAGE/BLOCK	INDIRECT REGISTERS	ADDRESS RANGE	DESCRIPTION
000	0	Digital Page 0 Indirect Registers	0x01 - 0x1F	Pattern Gen Registers
010	2	Indirect Registers: Die ID Data	0x00 - 0x040	Hold 16 bytes that correspond to Die ID data.

#### Table 143. Indirect Register Map Description

#### 7.7.133.1 Reserved

#### Table 144. Reserved (Address 0x00)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	RESERVED	R	0x00	Reserved

#### 7.7.133.2 PGEN\_CTL

#### Table 145. PGEN\_CTL (Address 0x01)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:1	RESERVED	R/W	0x0	Reserved
0	PGEN_ ENABLE	R/W	0x0	Pattern Generator Enable 1: Enable Pattern Generator 0: Disable Pattern Generator



## 7.7.133.3 PGEN\_CFG

#### Table 146. PGEN\_CFG (Address 0x02)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7	PGEN_ FIXED_EN	R/W	0x0	Fixed Pattern Enable Setting this bit enables Fixed Color Patterns. 0 : Send Color Bar Pattern 1 : Send Fixed Color Pattern
6	RESERVED	R/W	0x0	Reserved
5:4	NUM_ CBARS	R/W	0x3	Number of Color Bars 00 : 1 Color Bar 01 : 2 Color Bars 10 : 4 Color Bars 11 : 8 Color Bars
3:0	BLOCK_SIZE	R/W	0x3	Block Size For Fixed Color Patterns, this field controls the size of the fixed color field in bytes. Allowed values are 1 to 15.

## 7.7.133.4 PGEN\_CSI\_DI

#### Table 147. PGEN\_CSI\_DI (Address 0x03)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:6	PGEN_CSI_ VC	R/W	0x0	CSI-2 Virtual Channel Identifier This field controls the value sent in the CSI-2 packet for the Virtual Channel Identifier
5:0	PGEN_CSI_ DT	R/W	0x24	CSI-2 Data Type This field controls the value sent in the CSI-2 packet for the Data Type. The default value (0x24) indicates RGB888.

## 7.7.133.5 PGEN\_LINE\_SIZE1

#### Table 148. PGEN\_LINE\_SIZE1 (Address 0x04)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_LINE_ SIZE[15:8]	R/W	0x07	Most significant byte of the Pattern Generator line size. This is the active line length in bytes. Default setting is for 1920 bytes for a 640 pixel line width.

## 7.7.133.6 PGEN\_LINE\_SIZE0

#### Table 149. PGEN\_LINE\_SIZE0 (Address 0x05)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_LINE_ SIZE[7:0]	R/W	0x80	Least significant byte of the Pattern Generator line size. This is the active line length in bytes. Default setting is for 1920 bytes for a 640 pixel line width.

## 7.7.133.7 PGEN\_BAR\_SIZE1

#### Table 150. PGEN\_BAR\_SIZE1 (Address 0x06)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_BAR_ SIZE[15:8]	R/W	0x00	Most significant byte of the Pattern Generator color bar size. This is the active length in bytes for the color bars. This value is used for all except the last color bar. The last color bar is determined by the remaining bytes as defined by the PGEN_LINE_SIZE value.

## 7.7.133.8 PGEN\_BAR\_SIZE0

#### Table 151. PGEN\_BAR\_SIZE0 (Address 0x07)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_BAR_ SIZE[7:0]	R/W	0xF0	Least significant byte of the Pattern Generator color bar size. This is the active length in bytes for the color bars. This value is used for all except the last color bar. The last color bar is determined by the remaining bytes as defined by the PGEN_LINE_SIZE value.

## 7.7.133.9 PGEN\_ACT\_LPF1

#### Table 152. PGEN\_ACT\_LPF1 (Address 0x08)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ACT_ LPF[15:8]	R/W	0x01	Active Lines Per Frame Most significant byte of the number of active lines per frame. Default setting is for 480 active lines per frame.

#### 7.7.133.10 PGEN\_ACT\_LPF0

#### Table 153. PGEN\_ACT\_LPF0 (Address 0x09)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ACT_ LPF[7:0]	R/W	0xE0	Active Lines Per Frame Least significant byte of the number of active lines per frame. Default setting is for 480 active lines per frame.

#### 7.7.133.11 PGEN\_TOT\_LPF1

#### Table 154. PGEN\_TOT\_LPF1 (Address 0x0A)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_TOT_ LPF[15:8]	R/W	0x02	Total Lines Per Frame Most significant byte of the number of total lines per frame including vertical blanking

## 7.7.133.12 PGEN\_TOT\_LPF0

#### Table 155. PGEN\_TOT\_LPF0 (Address 0x0B)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_TOT_ LPF[7:0]	R/W	0x0D	Total Lines Per Frame Least significant byte of the number of total lines per frame including vertical blanking

#### 7.7.133.13 PGEN\_LINE\_PD1

## Table 156. PGEN\_LINE\_PD1 (Address 0x0C)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_LINE_ PD[15:8]	R/W		Line Period Most significant byte of the line period in 10-ns units. The default setting for the line period registers sets a line period of 31.75 microseconds.



## 7.7.133.14 PGEN\_LINE\_PD0

#### Table 157. PGEN\_LINE\_PD0 (Address 0x0D)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_LINE_ PD[7:0]	R/W	0x67	Line Period Least significant byte of the line period in 10-ns units. The default setting for the line period registers sets a line period of 31.75 microseconds.

## 7.7.133.15 PGEN\_VBP

## Table 158. PGEN\_VBP (Address 0x0E)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_VBP	R/W	0x21	Vertical Back Porch This value provides the vertical back porch portion of the vertical blanking interval. This value provides the number of blank lines between the FrameStart packet and the first video data packet.

## 7.7.133.16 PGEN\_VFP

#### Table 159. PGEN\_VFP (Address 0x0F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_VFP	R/W	0x0A	Vertical Front Porch This value provides the vertical front porch portion of the vertical blanking interval. This value provides the number of blank lines between the last video line and the FrameEnd packet.

## 7.7.133.17 PGEN\_COLOR0

#### Table 160. PGEN\_COLOR0 (Address 0x10)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR0	R/W	0xAA	Pattern Generator Color 0 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 0. For Fixed Color Patterns, this register controls the first byte of the fixed color pattern.

## 7.7.133.18 PGEN\_COLOR1

## Table 161. PGEN\_COLOR1 (Address 0x11)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR1	R/W	0x33	Pattern Generator Color 1 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 1. For Fixed Color Patterns, this register controls the second byte of the fixed color pattern.

#### 7.7.133.19 PGEN\_COLOR2

#### Table 162. PGEN\_COLOR2 (Address 0x12)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR2	R/W	0xF0	Pattern Generator Color 2 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 2. For Fixed Color Patterns, this register controls the third byte of the fixed color pattern.

## 7.7.133.20 PGEN\_COLOR3

#### Table 163. PGEN\_COLOR3 (Address 0x13)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR3	R/W	0x7F	Pattern Generator Color 3 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 3. For Fixed Color Patterns, this register controls the fourth byte of the fixed color pattern.

## 7.7.133.21 PGEN\_COLOR4

#### Table 164. PGEN\_COLOR4 (Address 0x14)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR4	R/W	0x55	Pattern Generator Color 4 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 4. For Fixed Color Patterns, this register controls the fifth byte of the fixed color pattern.

## 7.7.133.22 PGEN\_COLOR5

#### Table 165. PGEN\_COLOR5 (Address 0x15)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR5	R/W	0xCC	Pattern Generator Color 5 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 5. For Fixed Color Patterns, this register controls the sixth byte of the fixed color pattern.

#### 7.7.133.23 PGEN\_COLOR6

#### Table 166. PGEN\_COLOR6 (Address 0x16)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR6	R/W	0x0F	Pattern Generator Color 6 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 6. For Fixed Color Patterns, this register controls the seventh byte of the fixed color pattern.

## 7.7.133.24 PGEN\_COLOR7

#### Table 167. PGEN\_COLOR7 (Address 0x17)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR7	R/W	0x80	Pattern Generator Color 7 For Reference Color Bar Patterns, this register controls the byte data value sent during color bar 7. For Fixed Color Patterns, this register controls the eighth byte of the fixed color pattern.

## 7.7.133.25 PGEN\_COLOR8

#### Table 168. PGEN\_COLOR8 (Address 0x18)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR8	R/W	0x00	Pattern Generator Color 8 For Fixed Color Patterns, this register controls the ninth byte of the fixed color pattern.



## 7.7.133.26 PGEN\_COLOR9

#### Table 169. PGEN\_COLOR9 (Address 0x19)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR9	R/W	0x00	Pattern Generator Color 9 For Fixed Color Patterns, this register controls the tenth byte of the fixed color pattern.

## 7.7.133.27 PGEN\_COLOR10

#### Table 170. PGEN\_COLOR10 (Address 0x1A)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR10	R/W	0x00	Pattern Generator Color 10 For Fixed Color Patterns, this register controls the eleventh byte of the fixed color pattern.

## 7.7.133.28 PGEN\_COLOR11

#### Table 171. PGEN\_COLOR11 (Address 0x1B)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR11	R/W	0x00	Pattern Generator Color 11 For Fixed Color Patterns, this register controls the twelfth byte of the fixed color pattern.

## 7.7.133.29 PGEN\_COLOR12

## Table 172. PGEN\_COLOR12 (Address 0x1C)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR12	R/W	0x00	Pattern Generator Color 12 For Fixed Color Patterns, this register controls the thirteenth byte of the fixed color pattern.

## 7.7.133.30 PGEN\_COLOR13

## Table 173. PGEN\_COLOR13 (Address 0x1D)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR13	R/W	0x00	Pattern Generator Color 13 For Fixed Color Patterns, this register controls the fourteenth byte of the fixed color pattern.

#### 7.7.133.31 PGEN\_COLOR14

#### Table 174. PGEN\_COLOR14 (Address 0x1E)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR14	R/W	0x00	Pattern Generator Color 14 For Fixed Color Patterns, this register controls the fifteenth byte of the fixed color pattern.

# 7.7.133.32 PGEN\_COLOR15

# Table 175. PGEN\_COLOR15 (Address 0x1F)

BIT	FIELD	TYPE	DEFAULT	DESCRIPTION
7:0	PGEN_ COLOR15	R/W	0x00	Pattern Generator Color 15 For Fixed Color Patterns, this register controls the sixteenth byte of the fixed color pattern.



# 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 8.1 Application Information

The link between the DS90UB935-Q1 and the companion deserializer has two distinct data paths. The first path is a forward channel which is nominally running at up to 3.16 Gbps and is encoded such that the channel occupies a bandwidth from 20 MHz to 2.1 GHz. The second path is a back channel from the deserializer to the serializer which occupies a frequency range nominally from 10 MHz to 50 MHz.

For these two communications links to operate properly, the circuit between the serializer and the deserializer must present a characteristic impedance of 50  $\Omega$ . Deviations from this 50- $\Omega$  characteristic will lead to signal reflections either at the serializer or deserializer, which will result in bit errors.

#### 8.1.1 Power Over Coax

The DS90UB935-Q1 is designed to support the Power-over-Coax (PoC) method of powering remote sensor systems. With this method, the power is delivered over the same medium (a coaxial cable) used for high-speed digital video data and bidirectional control and diagnostics data transmission. This method uses passive networks or filters that isolate the transmission line from the loading of the DC-DC regulator circuits and their connecting power traces on both sides of the link as shown in Figure 15.

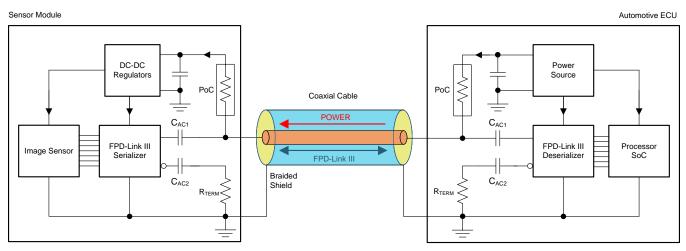


Figure 15. Power-over-Coax (PoC) System Diagram

The PoC network impedance of  $\geq 2 \ k\Omega$  over a specific frequency band is typically sufficient to isolate the transmission line from the loading of the regulator circuits. The lower limit of the frequency band is defined as  $\frac{1}{2}$  of the frequency of the bidirectional control channel' (f<sub>BCC</sub>). The upper limit of the frequency band is the frequency of the forward high-speed channel (f<sub>FC</sub>).

Figure 16 shows an example PoC network suitable for a "4G" FPD-Link III consisting of DS90UB935-Q1 and DS90UB936-Q1, DS90UB954-Q1, or DS90UB960-Q1 pair with the bidirectional channel operating at 50 Mbps ( $\frac{1}{2}$  f<sub>BCC</sub> = 25 MHz) and the forward channel operating at 3.16 Gbps ( $f_{FC} \approx 2.1$  GHz). Other PoC networks are possible and may be different on the serializer and the deserializer boards as long as the printed-circuit board return loss requirements given in Table 177 are met.

TEXAS INSTRUMENTS

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# **Application Information (continued)**

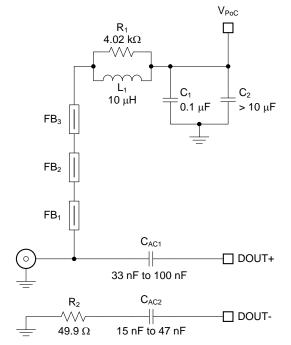


Figure 16. Typical PoC Network for a "4G" FPD-Link III

Table 176 lists essential components for this particular PoC network. Note that the impedance characteristic of the ferrite beads deviates with the bias current. Therefore, keeping the current going through the network below 150 mA is recommended.

Count	Ref Des	Description	Part Number	MFR
		Inductor, 10 $\mu$ H, 0.288 $\Omega$ max, 530 mA MIN(Isat, Itemp) 30 MHz SRF min, 3 mm x 3 mm, General Purpose	LQH3NPN100MJR	Murata
		Inductor, 10 $\mu$ H, 0.288 $\Omega$ max, 530 mA MIN(Isat, Itemp) 30 MHz SRF min, 3 mm x 3 mm, AEC-Q200	LQH3NPZ100MJR	Murata
1	1 L1	Inductor, 10 $\mu$ H, 0.360 $\Omega$ max, 450 mA MIN(Isat, Itemp) 30 MHz SRF min, 3.2 mm x 2.5 mm, AEC-Q200	NLCV32T-100K-EFD	TDK
		Inductor, 10 $\mu$ H, 0.400 $\Omega$ typ, 550 mA MIN(Isat, Itemp) 39 MHz SRF typ, 3 mm x 3 mm, AEC-Q200	TYS3010100M-10	Laird
		Inductor, 10 $\mu$ H, 0.325 $\Omega$ max, 725 mA MIN(Isat, Itemp) 41 MHz SRF typ, 3 mm x 3 mm, AEC-Q200	TYS3015100M-10	Laird
3	FB1-FB3	Ferrite Bead, 1500 k $\Omega$ at 1 GHz, 0.5 $\Omega$ max @ DC 500 mA @ 85°C, SM0603, General Purpose	BLM18HE152SN1	Murata
3	г <b>р</b> 1- <b>г</b> В3	Ferrite Bead, 1500 kΩ at 1 GHz, 0.5 Ω max @ DC 500 mA at 85°C, SM0603, AEC-Q200	BLM18HE152SZ1	Murata

Table 176. Suggested Components for	a "4G" FPD-Link III PoC Network
-------------------------------------	---------------------------------

In addition to the selection of PoC network components, their placement and layout play a critical role as well.

- Place the smallest component, typically a ferrite bead or a chip inductor, as close to the connector as possible. Route the high-speed trace through one of its pads to avoid stubs.
- Use the smallest component pads as allowed by manufacturer's design rules. Add anti-pads in the inner planes below the component pads to minimize impedance drop.
- Consult with the connector manufacturer for optimized connector footprint. If the connector is mounted on the same side as the IC, minimize the impact of the through-hole connector stubs by routing the high-speed signal traces on the opposite side of the connector mounting side.
- Use coupled 100- $\Omega$  differential signal traces from the device pins to the AC-coupling caps. Use 50- $\Omega$  single-



ended traces from the AC-coupling capacitors to the connector.

Terminate the inverting signal traces close to the connectors with standard 49.9-Ω resistors.

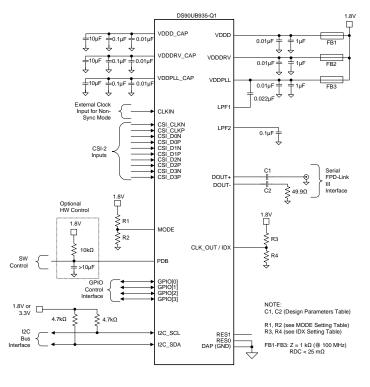
The suggested characteristics for single-ended PCB traces (microstrips or striplines) for serializer or deserializer boards are detailed in Table 177. The effects of the PoC networks must be accounted for when testing the traces for compliance to the suggested limits.

	PARAME	MIN	TYP	MAX	UNIT	
L <sub>trace</sub>	Single-ended PCB trace length from the			5	cm	
Z <sub>trace</sub>	Single-ended PCB trace characteristic im	45	50	55	Ω	
Z <sub>con</sub>	Connector (mounted) characteristic impe	40	50	60	Ω	
RL		½ f <sub>BCC</sub> < f < 0.1 GHz			-25	dB
	Return Loss, S11	0.1 GHz < f < 1 GHz (f in GHz)	-26.4+14.4f			dB
		1 GHz < f < f <sub>FC</sub>		-12		dB
IL		f < 0.5 GHz	-0.35			dB
	Insertion Loss, S12	f =1 GHz	-0.6			dB
		f =2.1 GHz	-1.2			dB

The V<sub>POC</sub> fluctuations on the serializer side, caused by the transient current draw of the sensor, the DC resistance of cables, and PoC components, must be kept to a minimum as well. Increasing the V<sub>POC</sub> voltage and adding extra decoupling capacitance (> 10  $\mu$ F) help reduce the amplitude and slew rate of the V<sub>POC</sub> fluctuations.

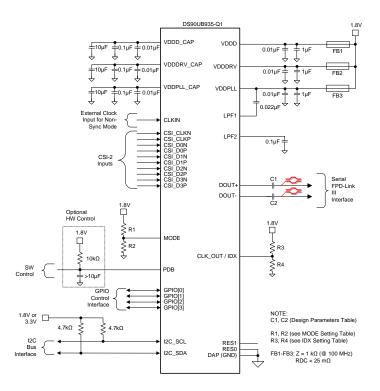


## 8.2 Typical Applications



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#### Figure 18. Typical Connection Diagram STP



# **Typical Applications (continued)**

## 8.2.1 Design Requirements

For a typical design application, use the parameters listed in Table 178.

DESIGN PARAMETER	PIN(S)	VALUE				
V <sub>(VDD)</sub>	VDDD, VDDDRV, VDDPLL	1.8 V				
AC-Coupling Capacitor for	DOUT+	33nF – 100 nF (50 V / X7R / 0402)				
Synchronous Modes, Coaxial Connection	DOUT-	15nF – 47 nF (50 V / X7R / 0402)				
AC-Coupling Capacitor for Synchronous Modes, STP Connection	DOUT+, DOUT-	33 – 100 nF (50 V / X7R / 0402)				
AC-Coupling Capacitor for Non-	DOUT+	100 nF (50 V / X7R / 0402)				
Synchronous and DVP Backwards Compatible Modes, Coaxial Connection	DOUT-	47 nF (50 V / X7R / 0402)				
AC-Coupling Capacitor for Non- Synchronous and DVP Backwards Compatible Modes, STP Connection	DOUT+, DOUT-	100 nF (50 V / X7R / 0402)				

T	ab	le	17	78.	Desi	gn	Par	ame	ters
---	----	----	----	-----	------	----	-----	-----	------

The SER/DES only supports AC-coupled interconnects through an integrated DC-balanced decoding scheme. External AC-coupling capacitors must be placed in series in the FPD-Link III signal path as shown in Figure 19 and Figure 20. For applications using single-ended 50- $\Omega$  coaxial cable, terminate the unused data pins (DOUT+, DOUT-) with an AC-coupling capacitor and a 50- $\Omega$  resistor.

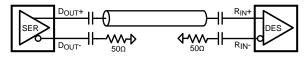


Figure 19. AC-Coupled Connection (Coaxial)

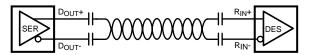


Figure 20. AC-Coupled Connection (STP)

For high-speed FPD–Link III transmissions, use the smallest available package for the AC-coupling capacitor to help minimize degradation of signal quality due to package parasitics.

#### 8.2.2 Detailed Design Procedure

Figure 17 shows a typical application circuit of the DS90UB935-Q1. The next sections highlight recommendations for the critical device pins.

#### 8.2.2.1 CSI-2 Interface

The CSI-2 input port on the DS90UB935-Q1 is compliant with the MIPI D-PHY v1.2 and CSI-2 v1.3 specifications. The CSI-2 interface consists of a clock and an option of one, two, or four data lanes. The clock and each of the data lanes are differential lines. The DS90UB935-Q1 CSI-2 input needs to be DC coupled to a compatible CSI-2 transmitter. Follow PCB layout guidelines given in *CSI-2 Guidelines*.

#### 8.2.2.2 FPD-Link III Input / Output

The DS90UB935-Q1 serial data out signal operates at different data rates depending upon the mode in which the device is operating. In synchronous mode, where the reference clock is provided by the deserializer, the serial data rate is up to 3.16 Gbps.

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DS90UB935-Q1 SNLS605 – JULY 2018



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The signals at DOUT+ and DOUT- must be AC-coupled. The AC-coupling capacitor values used on DOUT+ and DOUT- depends on the mode and cable used as shown in Table 178. When connecting to a coax cable, the AC-coupling capacitor on the negative terminal (DOUT-) should be approximately  $\frac{1}{2}$  of the AC-coupling capacitor value on DOUT+ and be terminated to a 50- $\Omega$  load. Adhering to the PCB layout guidelines given in *Layout Examples* is critical.

## 8.2.2.3 Internal Regulator Bypassing

The DS90UB935-Q1 features three internal regulators that must be bypassed to GND. The VDDD\_CAP, VDDDRV\_CAP, and VDDPLL\_CAP are the pins that expose the outputs of the internal regulators for bypassing. TI recommends that each pin has a 10- $\mu$ F, 0.1- $\mu$ F, and a 0.01- $\mu$ F capacitor to GND. The 0.01- $\mu$ F caps must be placed as close as practical to the bypass pins.

## 8.2.2.4 Loop Filter Decoupling

The LPF1 and LPF2 pins are for connecting filter capacitors to the internal PLL circuits. LPF1 should have a 0.022- $\mu$ F capacitor connected to the VDD\_PLL pin (pin 11). The capacitor connected between LPF1 and VDDPLL must enclose as small of a loop as possible. LPF2 must have a 0.1- $\mu$ F capacitor connecting the pin to GND. One of these PLLs generates the high-speed clock used in the serialization of the output, while the other PLL is used in the CSI-2 receive port. Noise coupled into these pins degrades the performance of the PLLs in the DS90UB935-Q1, so the caps must be placed close to the pins they are connected to, and the area of the loop enclosed must be minimized.

#### 8.2.3 Application Curve

The falling edge of the blue trace indicates that the device should shift from LP to HS mode – the rise that comes about one division later is when the DS90UB935-Q1 turns on the internal termination so the device is ready to receive HS data. The transitions are the CSI-2 data, and then the drop of the blue trace indicates that the termination has been turned off.

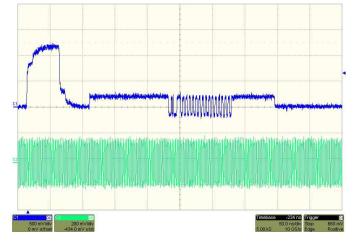


Figure 21. CSI-2 LP to HS Mode Transition



### 9 Power Supply Recommendations

This device provides separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. The *Pin Configuration and Functions* section provides guidance on which circuit blocks are connected to which power pin pairs. In some cases, an external filter many be used to provide clean power to sensitive circuits such as PLLs.

### 9.1 Power-Up Sequencing

The power-up sequence for the DS90UB935-Q1 is as follows:

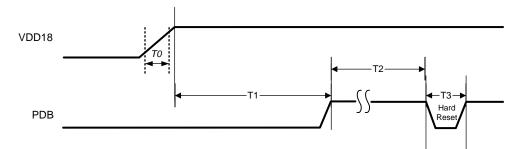


Figure 22. Power Supply Sequencing

Table 179.	Timing Diagram	for the Power	Supply Sta	art-Up and Ini	tialization Sequences
	rinning Blagran			ant op and nin	anzation ooquonooo

	PARAMETER	MIN	TYP	MAX	UNIT	NOTES
TO	VDD18 rise time	0.05			ms	at 10/90%
T1	VDD18 to PDB	0			ms	After VDD18 is stable
T2	PDB high time before PDB hard reset	1			ms	
Т3	PDB high to low pulse width	3			ms	Hard reset
T4	PDB to I2C Ready	2			ms	See

#### 9.1.1 System Initialization

When initializing the communications link between a deserializer hub and a DS90UB935-Q1 serializer, the system timing will depend on the mode selected for generating the serializer reference clock. When synchronous clocking mode is selected, the serializer will relock onto the extracted back channel reference clock when available, so there is no need for local crystal oscillator at the sensor module. The initialization sequence follows the illustration given in Figure 23.

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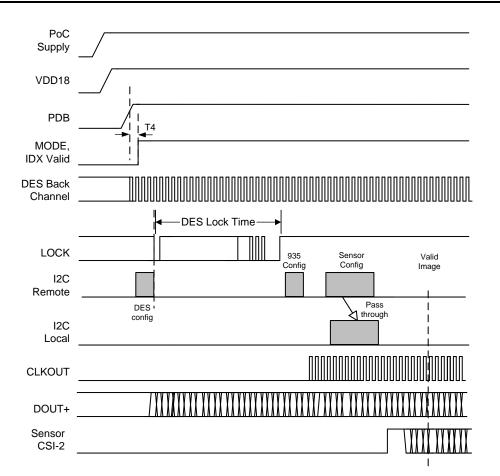


Figure 23. Initialization Sequence: Synchronous Clocking Mode

### 9.2 Power Down (PDB)

The Serializer has a PDB input pin to ENABLE or POWER DOWN the device. This pin may be controlled by an external device, or through VDD where VDD = 1.71 V to 1.89 V. PDB should be brought high after all power supplies on the board have stabilized.

When PDB is driven low, ensure that the pin is driven to 0 V for at least 3 ms before releasing or driving high. In the case where PDB is pulled up to VDD directly, a 10-k $\Omega$  pullup resistor and a > 1- $\mu$ F capacitor to ground are required.

Toggling PDB low powers down the device and resets all control registers to default. After power up, if there are any errors seen, TI recommends clearing the registers to reset the errors.

Make sure to power up the VDDDRV before or at the same time as the VDDPLL.

## 10 Layout

### **10.1 Layout Guidelines**

Circuit board layout and stack-up for the FPD-Link III devices must be designed to provide low-noise power feed to the device. Good layout practice also separates high frequency or high-level inputs and outputs to minimize unwanted stray noise pickup, feedback, and interference. External bypassing should be low-ESR ceramic capacitors with high-quality dielectric. The voltage rating of the ceramic capacitors must be at least 2× the power supply voltage being used.



TI recommends surface-mount capacitors due to their smaller parasitics. When using multiple capacitors per supply pin, place the smaller value closest to the pin. A large bulk capacitor is recommend at the point of power entry. This is typically in the 47- $\mu$ F to 100- $\mu$ F range, which smooths low-frequency switching noise. TI recommends connecting power and ground pins directly to the power and ground planes with bypass capacitors connected to the plane. TI also recommends that the user place a via on both ends of the capacitors. Connecting power or ground pins to an external bypass capacitor increases the inductance of the path.

A small body size X7R chip capacitor, such as 0603 or 0402, is recommended for external bypass. The small body size reduces the parasitic inductance of the capacitor. The user must pay attention to the resonance frequency of these external bypass capacitors, usually in the range of 20 to 30 MHz. To provide effective bypassing, multiple capacitors are often used to achieve low impedance between the supply rails over the frequency of interest. At high frequency, it is also a common practice to use two vias from power and ground pins to the planes, reducing the impedance at high frequency.

Some devices provide separate power and ground pins for different portions of the circuit. This is done to isolate switching noise effects between different sections of the circuit. Separate planes on the PCB are typically not required. Pin Description tables typically provide guidance on which circuit blocks are connected to which power pin pairs (see *Pin Configuration and Functions* for more information). In some cases, an external filter may be used to provide clean power to sensitive circuits such as PLLs.

Use at least a four-layer board with a dedicated ground plane. Place CSI-2 signals away from the single-ended or differential FPD-Link III RX input traces to prevent coupling from the CSI-2 lines to the Rx input lines. A single-ended impedance of 50  $\Omega$  is typically recommended for coaxial interconnect, and a differential impedance of 100  $\Omega$  is typically recommended for STP interconnect. The closely coupled lines help to ensure that coupled noise appears as common-mode and thus is rejected by the receivers. The tightly coupled lines also radiate less.

#### 10.1.1 CSI-2 Guidelines

- 1. Route CSI0\_D\*P/N pairs with controlled 100-Ω differential impedance (±20%) or 50-Ω single-ended impedance (±15%).
- 2. Keep away from other high-speed signals.
- 3. Keep length difference between a differential pair to 5 mils of each other.
- 4. Length matching should be near the location of mismatch.
- 5. Match trace lengths between the clock pair and each data pair to be < 25 mils.
- 6. Separate each pair by at least 3 times the signal trace width.
- 7. Keep the use of bends in differential traces to a minimum. When bends are used, the number of left and right bends must be as equal as possible, and the angle of the bend should be ≥ 135 degrees. This arrangement minimizes any length mismatch caused by the bends and therefore minimizes the impact that bends have on EMI.
- 8. Route all differential pairs on the same layer to help match trace impedance characteristics.
- 9. Keep the number of VIAS to a minimum—TI recommends keeping the VIA count to two or fewer.
- 10. Keep traces on layers adjacent to ground plane.
- 11. Do NOT route differential pairs over any plane split.

## NOTE

Adding Test points causes impedance discontinuity and therefore negatively impacts signal performance. If test points are used, place them in series and symmetrically. Test points must not be placed in a manner that causes a stub on the differential pair.

### **10.2 Layout Examples**

The board layout for the DS90UB953-Q1EVM is shown in Figure 24 and Figure 25. All EVM layers are included in *DS90UB953-Q1EVM User's Guide* (SNLU224).

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#### Layout Examples (continued)

Routing the FPD-Link III signal traces between the DOUT pins and the connector, as well as connecting the PoC filter to these traces, are the most critical pieces of a successful DS90UB935-Q1 PCB layout. The following list provides essential recommendations for routing the FPD-Link III signal traces between the driver output pins and the FAKRA connector, as well as connecting the PoC filter.

- The routing of the FPD-Link III traces may be all on the top layer or partially embedded in middle layers if EMI is a concern.
- The AC-coupling capacitors should be on the top layer and very close to the receiver input pins to minimize the length of coupled differential trace pair between the pins and the capacitors.
- Route the DOUT+ trace between the AC-coupling capacitor and the FAKRA connector as a 50-Ω singleended micro-strip with tight impedance control (±10%). Calculate the proper width of the trace for a 50-Ω impedance based on the PCB stack-up. Ensure that the trace can carry the PoC current for the maximum load presented by the remote sensor module.
- The PoC filter should be connected to the DOUT+ trace through the ferrite bead or an RF inductor. The ferrite bead should be touching the high-speed trace to minimize the stub length seen by the transmission line. Create an anti-pad or a moat under the ferrite bead pad that touches the trace. The anti-pad should be a plane cutout of the ground plane directly underneath the top layer without cutting out the ground reference under the trace. The purpose of the anti-pad is to maintain the impedance as close to 50 Ω as possible.
- When routing DOUT+ on inner layers, length matching for single-ended traces does not provide a significant benefit. If the user wants to route the DOUT+ on the top or bottom layer, route the DOUT- trace loosely coupled to the DOUT+ trace for the length similar to the DOUT+ trace length. This may help the differential nature of the receiver to cancel out any common-mode noise that may be present in the environment that may couple on to the signal traces.

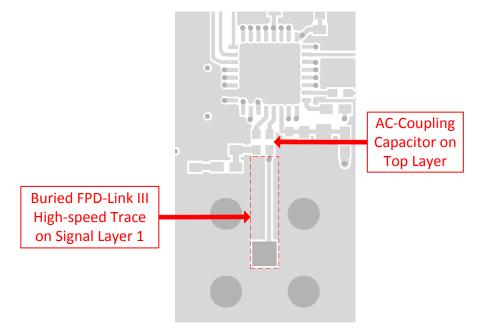


Figure 24. DS90UB935-Q1 Serializer DOUT+ Trace Layout



## Layout Examples (continued)

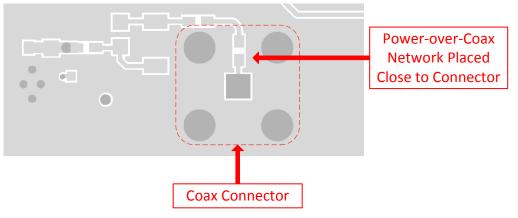


Figure 25. DS90UB935-Q1 Power-over-Coax Layout



## **11** Device and Documentation Support

#### 11.1 Device Support

#### 11.1.1 Development Support

For development support, see the following: DS90UB935-Q1

#### **11.2 Documentation Support**

#### 11.2.1 Related Documentation

For related documentation see the following:

- How to Design a FPD-Link III System (SNLA267)
- I2C Communication Over FPD-Link III With Bidirectional Control Channel (SNLA131)
- I2C Bus Pullup Resistor Calculation (SLVA689)
- FPD-Link Learning Center Training Material
- An EMC/EMI System-Design and Testing Methodology for FPD-Link III SerDes (SLYT719)
- Ten Tips for Successfully Designing With Automotive EMC/EMI Requirements (SLYT636)
- Backwards Compatibility Modes for Operation With Parallel Output Deserializers (SNLA270)
- Power-over-Coax Design Guidelines (SNLA272)
- Schematic and Layout Checklist (SNLA271)

#### 11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### **11.4 Community Resources**

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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solve problems with fellow engineers.

**Design Support TI's Design Support** Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 11.5 Trademarks

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#### **11.6 Electrostatic Discharge Caution**



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 11.7 Glossary

#### SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.



## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

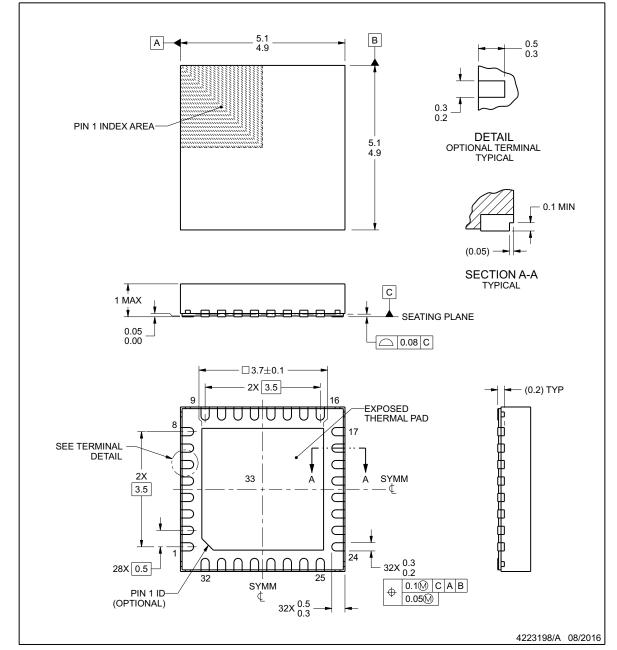


**RHB0032P** 



## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.

3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

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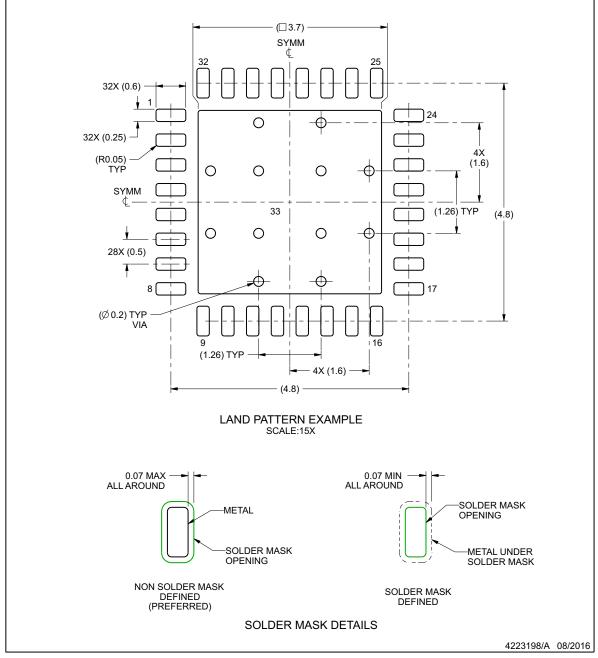
**RHB0032P** 

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# **EXAMPLE BOARD LAYOUT**

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
 Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

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**RHB0032P** 

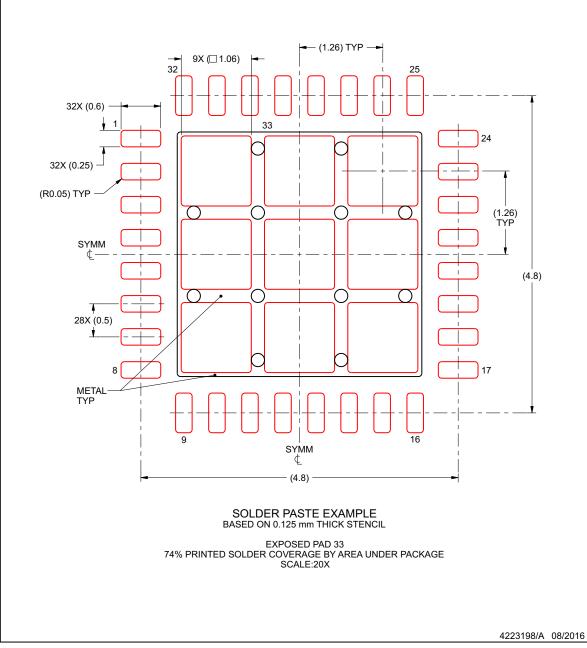
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# **EXAMPLE STENCIL DESIGN**

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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# PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
DS90UB935TRHBRQ1	ACTIVE	VQFN	RHB	32	3000	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 105	UB935	Samples
DS90UB935TRHBTQ1	ACTIVE	VQFN	RHB	32	250	Green (RoHS & no Sb/Br)	CU SN	Level-3-260C-168 HR	-40 to 105	UB935	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW**: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

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# PACKAGE MATERIALS INFORMATION

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## TAPE AND REEL INFORMATION





## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
DS90UB935TRHBRQ1	VQFN	RHB	32	3000	330.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2
DS90UB935TRHBTQ1	VQFN	RHB	32	250	180.0	12.4	5.3	5.3	1.1	8.0	12.0	Q2

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# PACKAGE MATERIALS INFORMATION

25-Jul-2018



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
DS90UB935TRHBRQ1	VQFN	RHB	32	3000	367.0	367.0	35.0
DS90UB935TRHBTQ1	VQFN	RHB	32	250	210.0	185.0	35.0



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) Package configuration.
- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.
- F. Falls within JEDEC MO-220.



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